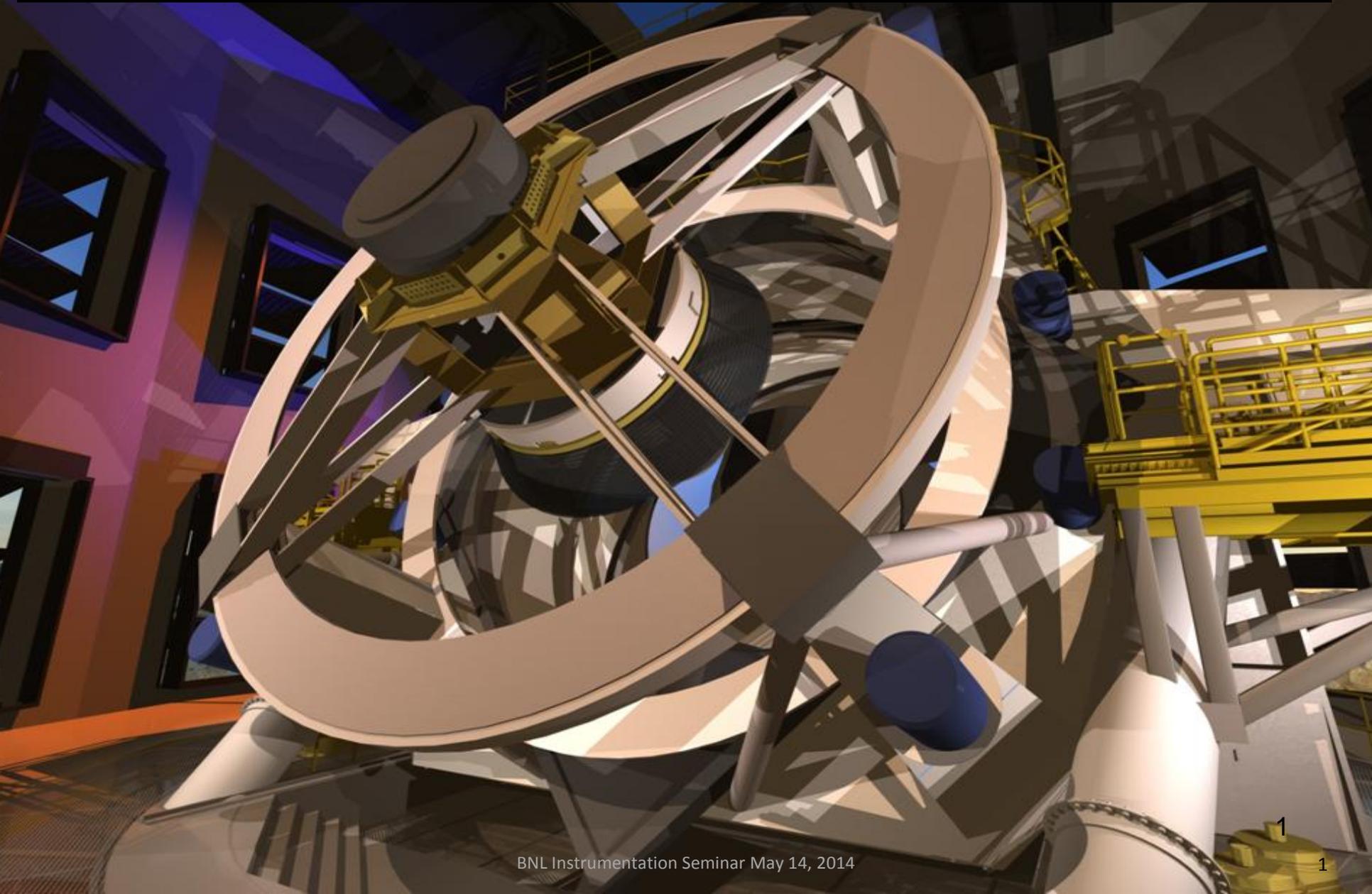


# LSST Camera Sensors and Front End Electronics

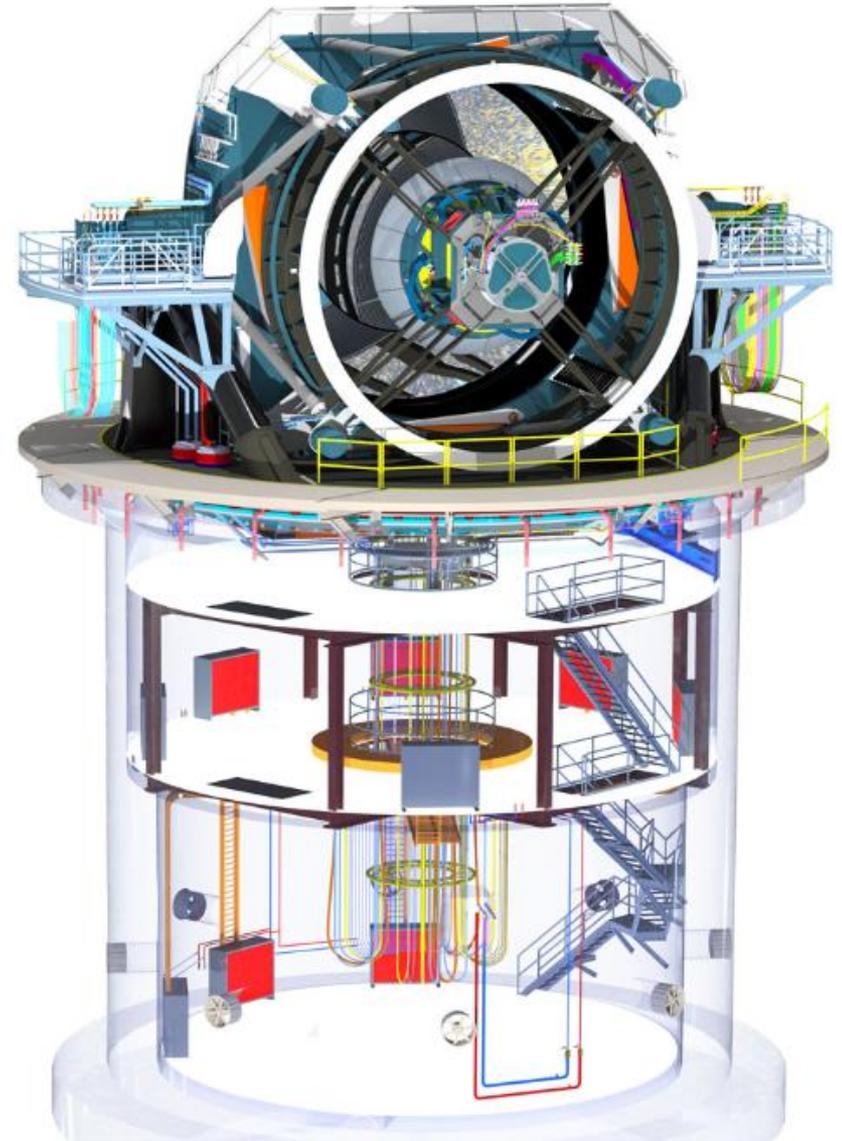
P. O'Connor, 2014-05-14





# LSST in a Nutshell

- LSST is designed to conduct a decade-long survey of the sky in the optical, using a novel 8-m class ground-based telescope and a 3.2Gpixel camera whose key focal plane components are being fabricated here at BNL.
- Data products will include:
  - A catalog of 37 billion sources
  - Real-time alerts to tens of billions of time domain events
- The LSST will enable a wide variety of complementary scientific investigations, including:
  - Mapping the dark matter distribution
  - Precision estimates of the dark energy equation of state parameters
  - Testing the  $\Lambda$ CDM paradigm of composition and expansion of the universe, search for new physics
  - Neutrino properties ( $\Sigma_{m\nu}$ ,  $N_{eff}$ )
- Cost and schedule:
  - Telescope, site, DM: \$473M
  - Camera: \$165M
  - Operations: \$37M/yr
  - First light: 2019
  - Survey operations start: 2022





# Summary of High Level Requirements

Survey Property	Performance
Main Survey Area	18000 sq. deg.
Total visits per sky patch	825
Filter set	6 filters (ugrizy) from 320 to 1050nm
Single visit	2 x 15 second exposures
Single Visit Limiting Magnitude	u = 23.5; g = 24.8; r = 24.4; l = 23.9; z = 23.3; y = 22.1
Photometric calibration	2% absolute, 0.5% repeatability & colors
Median delivered image quality	~ 0.7 arcsec. FWHM
Transient processing latency	60 sec after last visit exposure
Data release	Full reprocessing of survey data annually

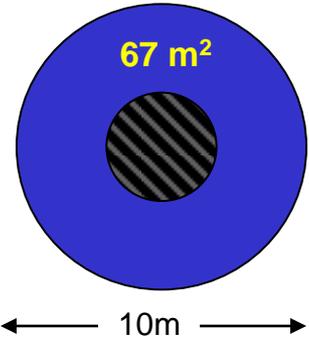


# Etendue is the figure of merit for astronomical survey instruments

Keck

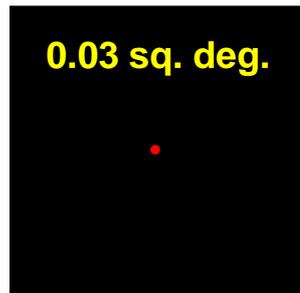


Primary mirror effective area



X

Field of view = Étendue  
 $A\Omega$



**2 m<sup>2</sup>-deg<sup>2</sup>**

Oschin Schmidt

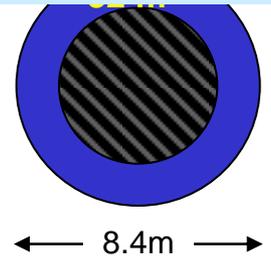
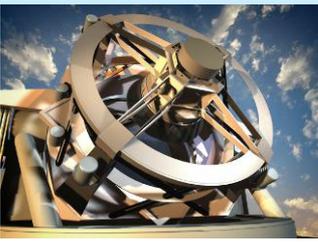
Astronomical investigations at the largest telescopes are typically done on small samples of cosmic sources or individual objects. The telescopes used for these investigations typically had rather small fields



done on small samples of cosmic sources or individual objects. The telescopes used for these investigations typically had rather small fields

**20 m<sup>2</sup>-deg<sup>2</sup>**

... and those with large fields of view could not detect very faint sources.



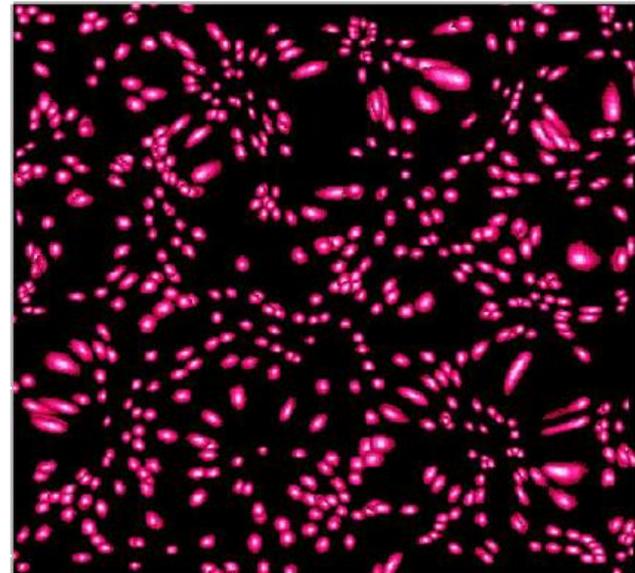
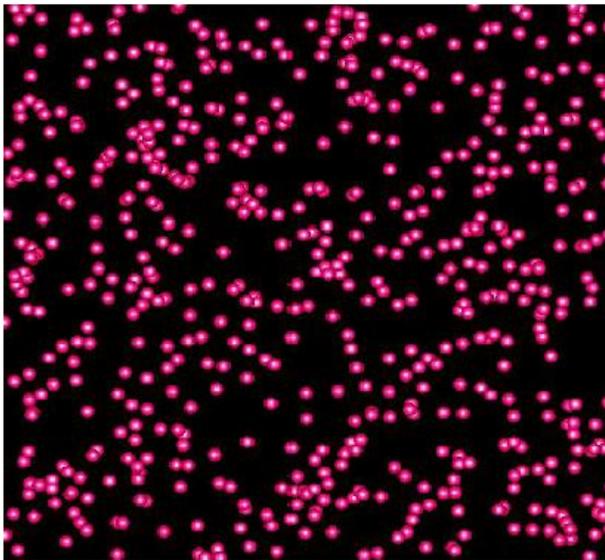
**320 m<sup>2</sup>-deg<sup>2</sup>**

**LSST combines large aperture and field of view to go WIDE and DEEP.**



# weak gravitational lensing

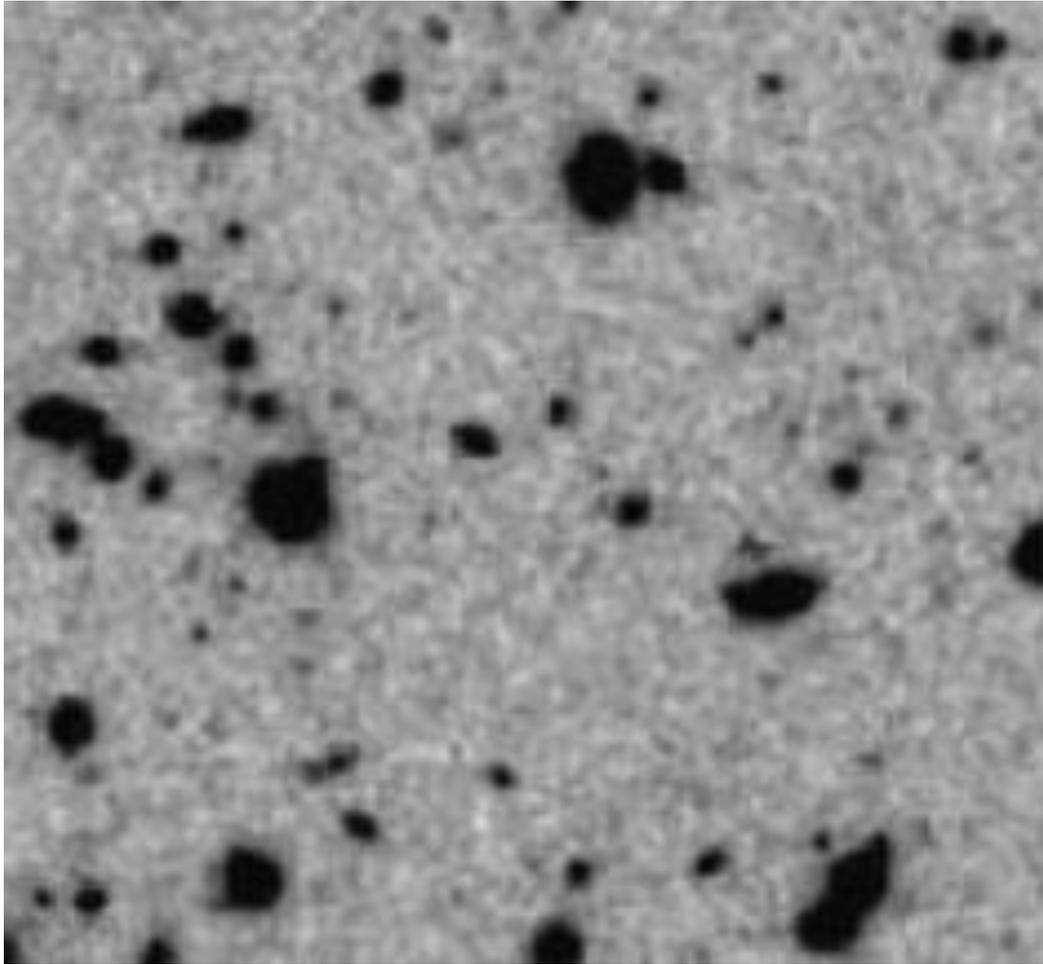
- is a small distortion ( $< 1\%$ ) of galaxy shapes
- is detected *statistically* by sampling many galaxies
  - $\sim 40$  detected galaxies per square arcminute
- the projected mass distribution can be obtained from properties of the shear field
- is unique in that it is *sensitive to mass*, not light
- sets the tightest constraints on LSST sensor properties, as it requires accurate *shape, flux, color, and position* of the *faintest, smallest* galaxies





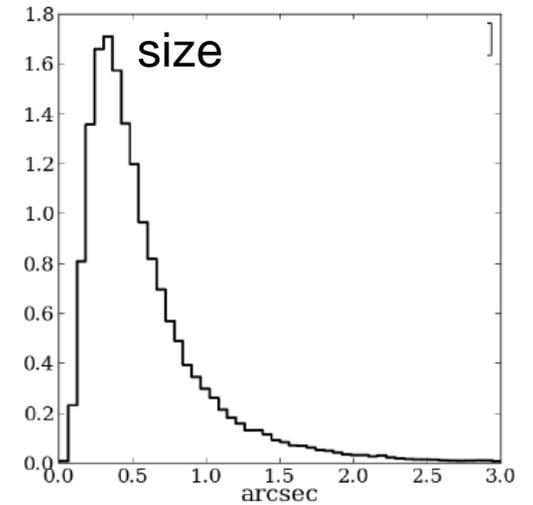
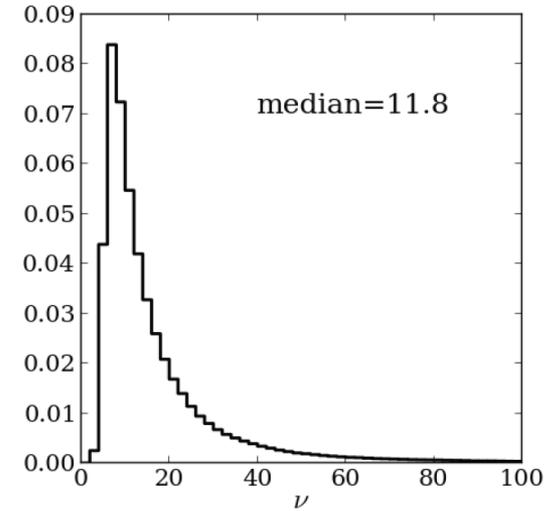
# Typical galaxy field at LSST depth

deep image from Subaru – another 8m telescope



Miyazaki et al. 2011

signal-to-noise

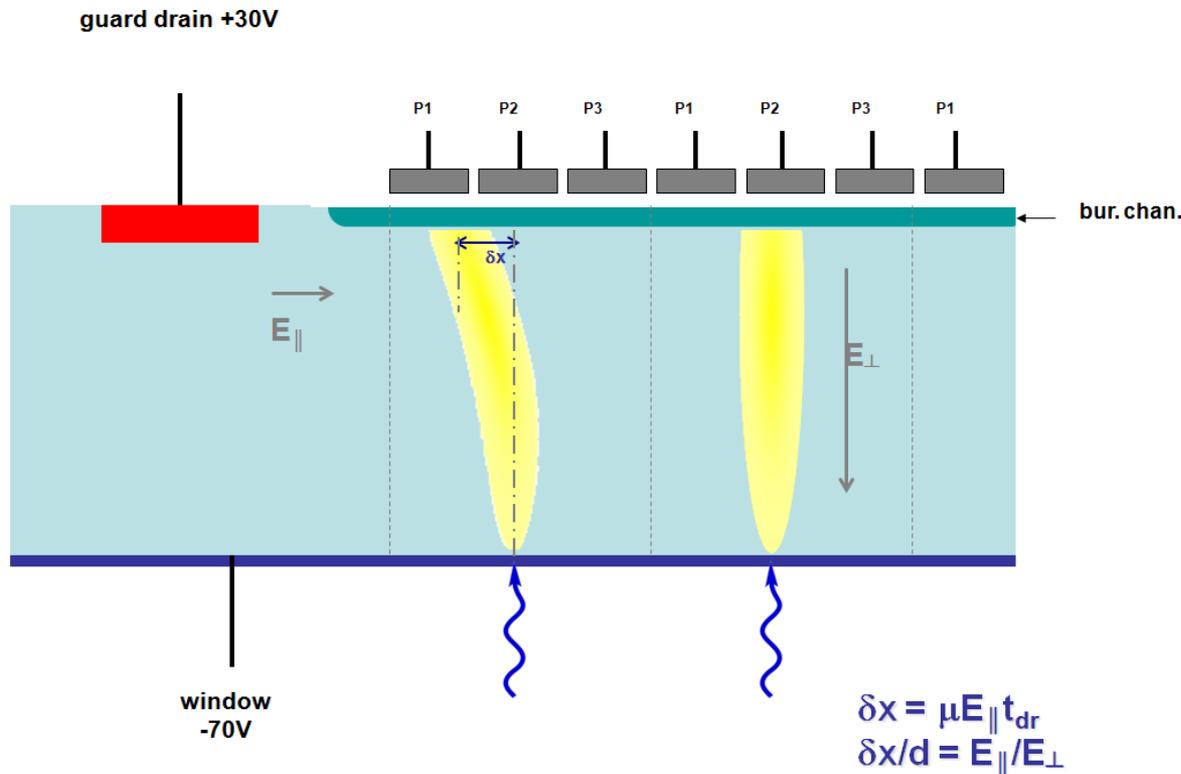


Chang et al. 2013

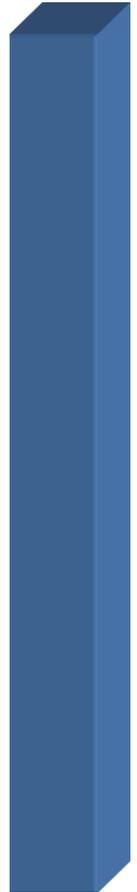


# Electrostatics in thick, fully-depleted CCDs

- LSST needs sensitivity to the near infrared and which leads to a choice to use back-illuminated, thick, fully-depleted sensors. Most previous cameras have used silicon CCDs made on epitaxial material about 10-20 microns thick, with pixels in the range of 15 - 25 microns square.
- Lateral electric fields (from broken symmetry at edges of array, or doping inhomogeneities in the silicon crystal) cause paths of photogenerated electrons in a thick sensor to bend.
- The collected charge may not reproduce the optical intensity field.



conventional pixel

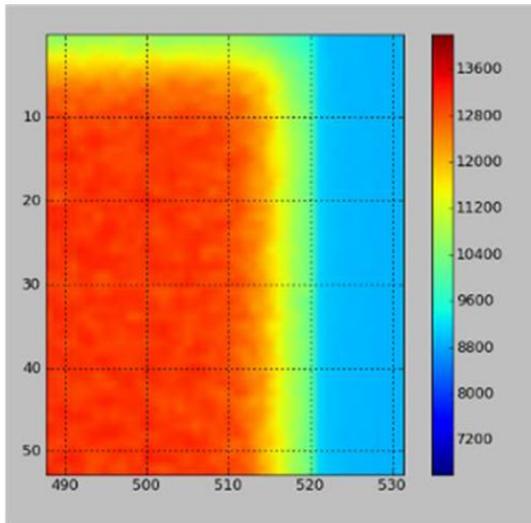


LSST pixel



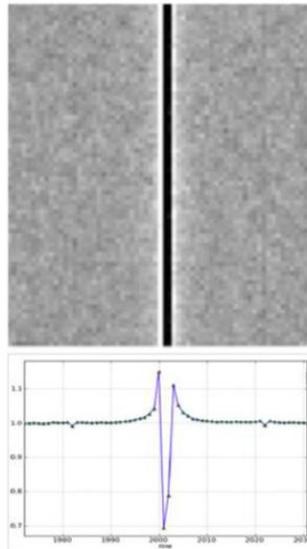
# Effects of lateral fields

## Flatfield illumination (laboratory)

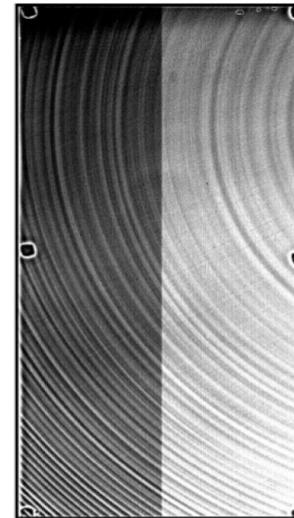


(a) Edge rolloff

*LSST prototype, 100um, n-channel*



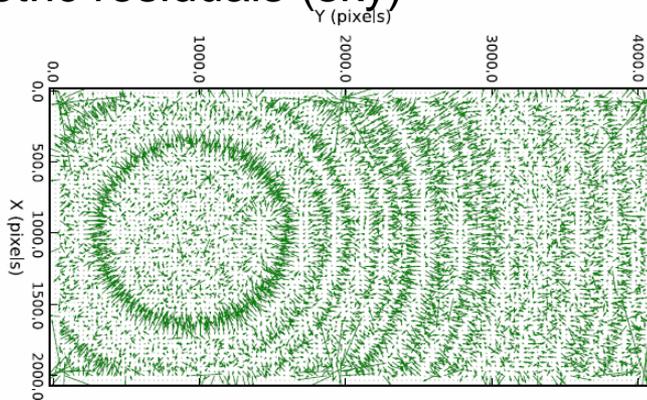
(b) Midline



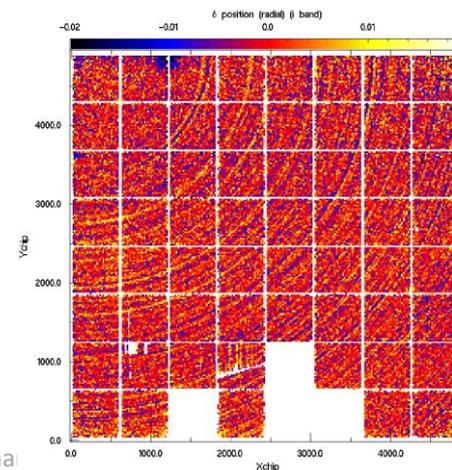
(c) Radial resistivity variation

*DECam, 200um, p-channel*

## Astrometric residuals (sky)



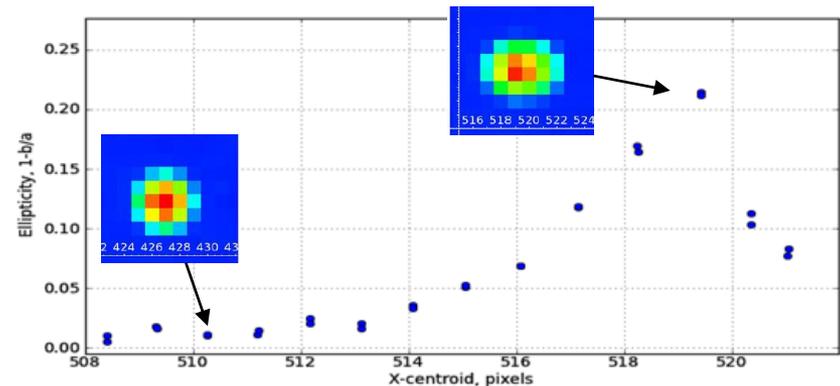
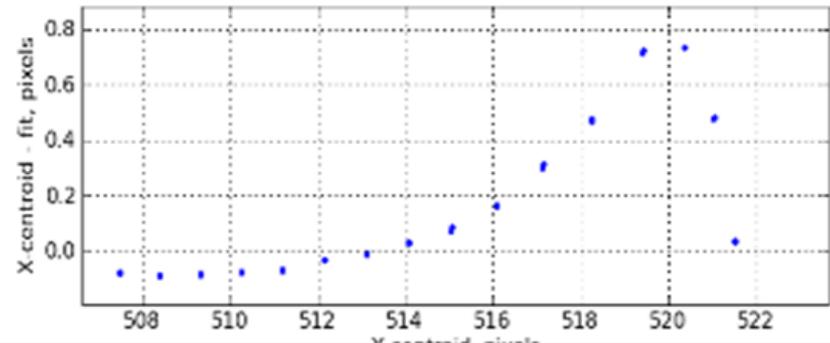
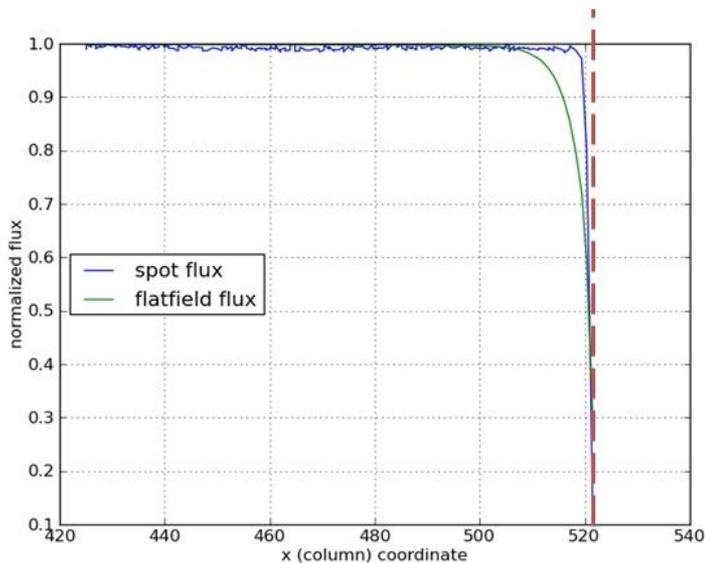
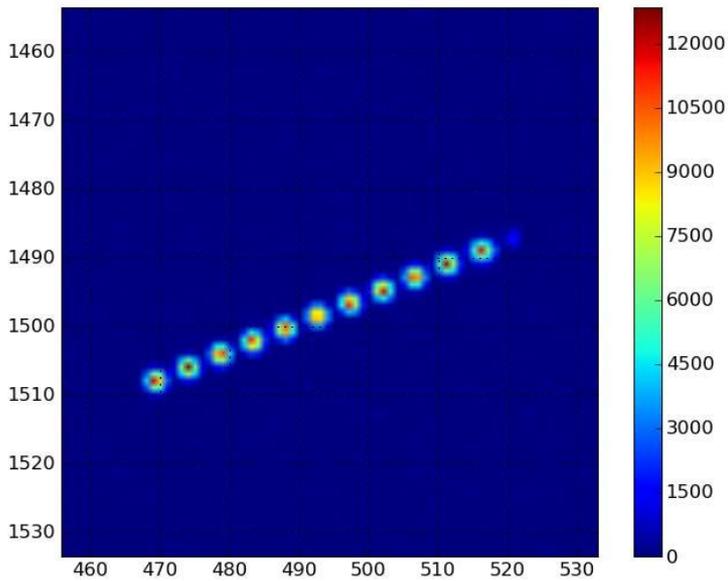
*Dark Energy Survey (A. Plazas et al.)*



*PanSTARRS (G. Magnier)*



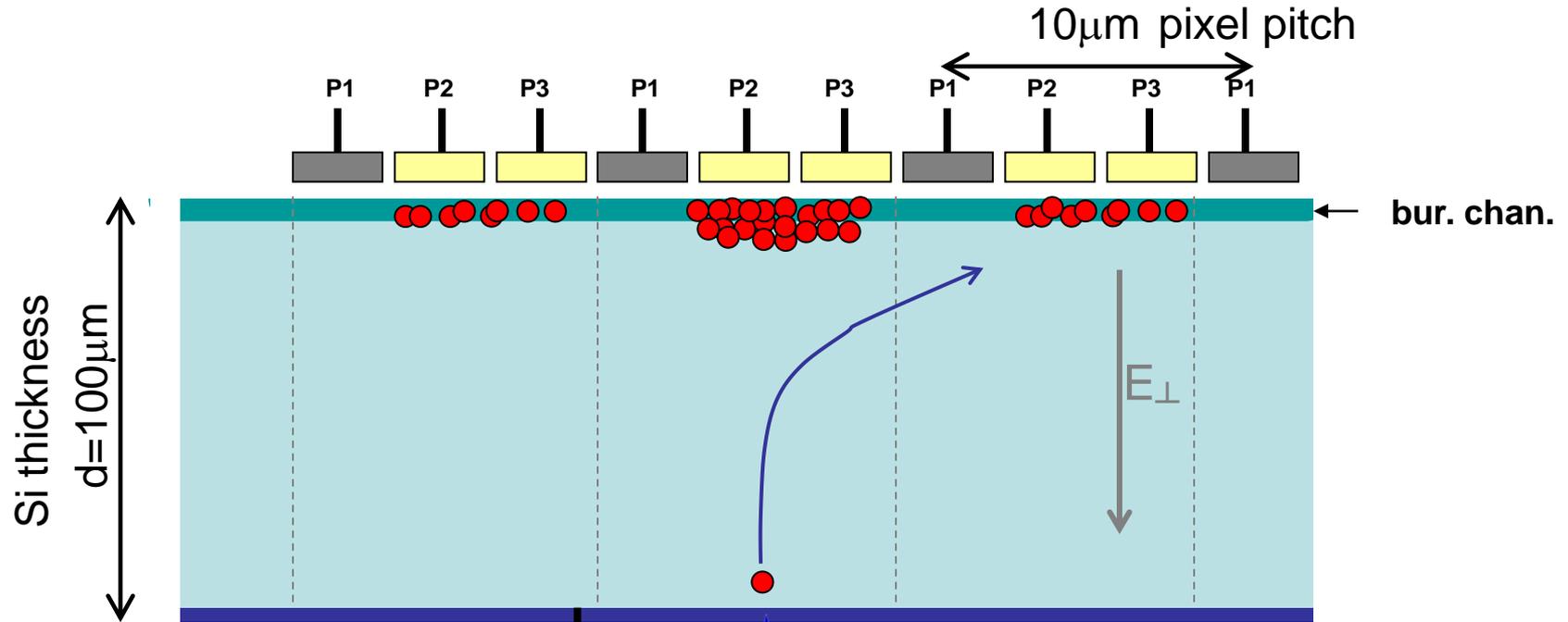
# Edge response spot projector and flat field data



- scan a small spot of light through the edge rolloff region
- its intensity is unchanged (left)
- position and ellipticity are distorted (above)
- profile is stretched and position is shifted towards the attractive guard ring potential
- shape distortion significant for WL



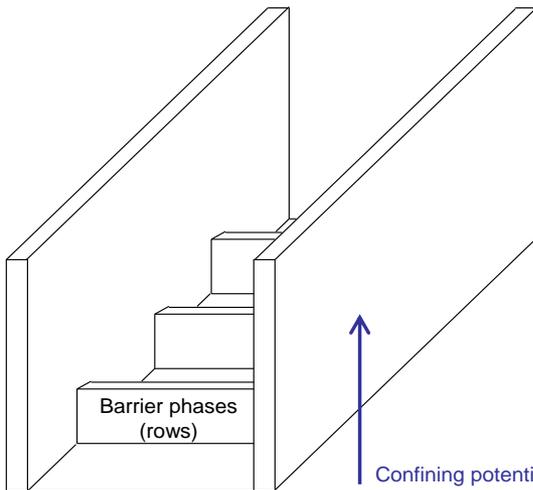
# Charge correlation and intensity-induced PSF broadening



window  
-70V

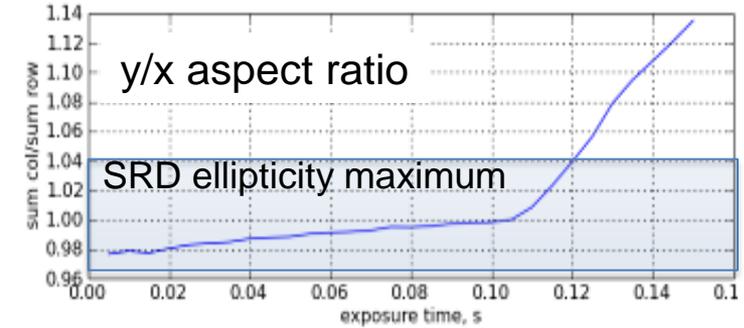
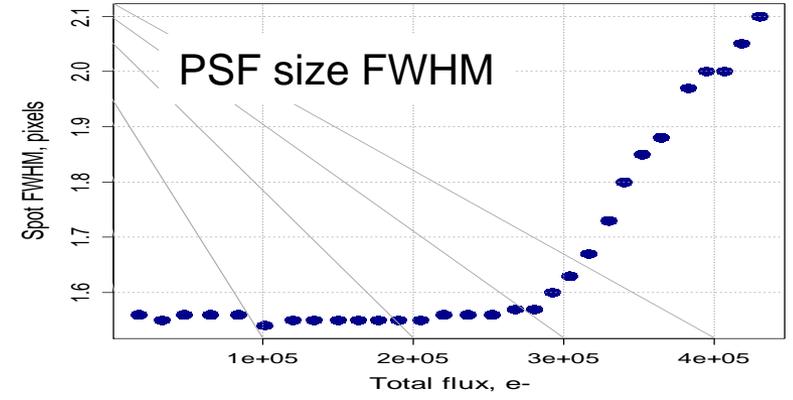
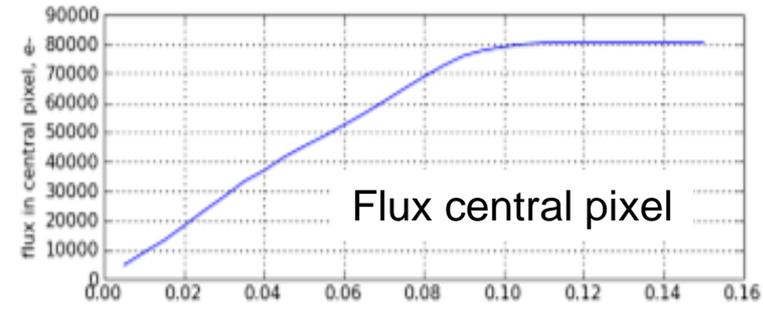
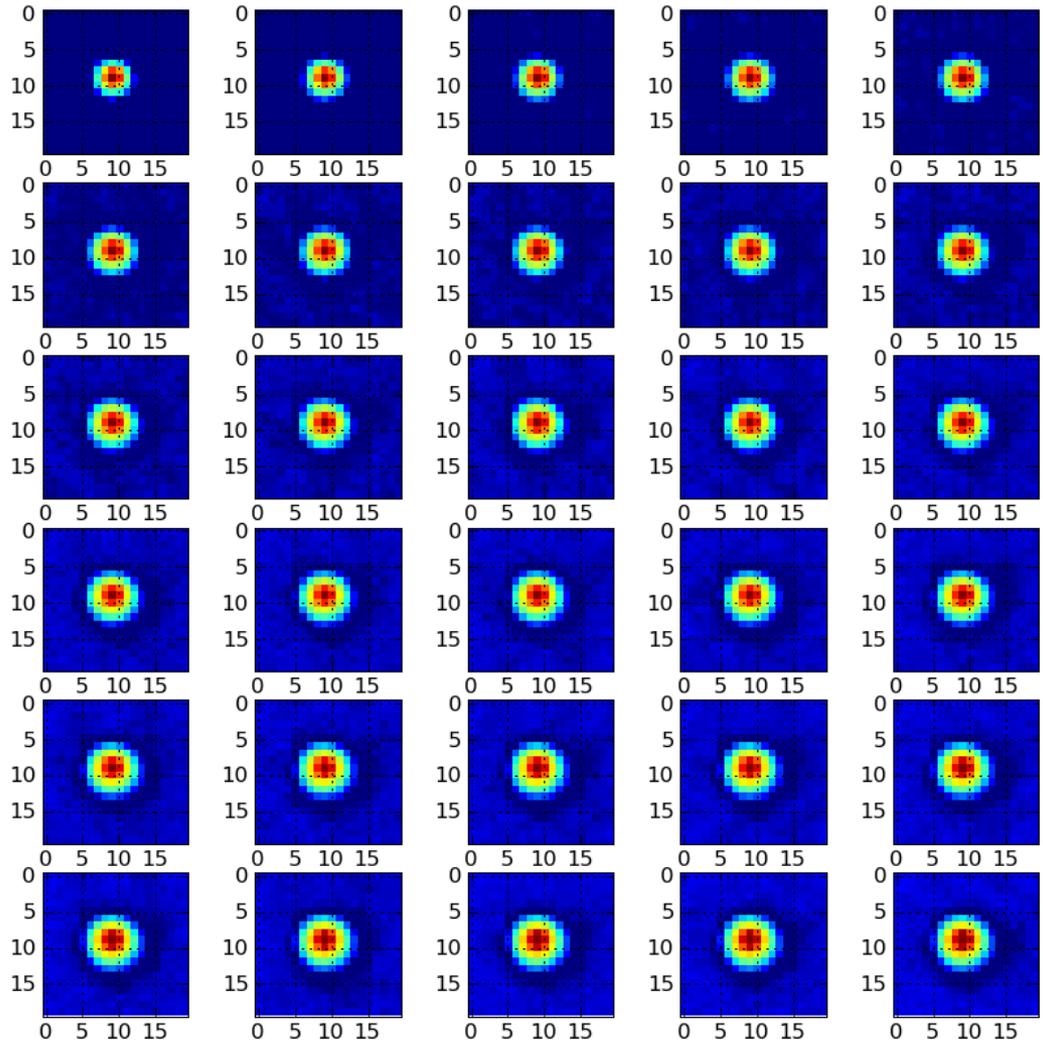
Electric field of stored charge in pixels with high signal counteracts  $E_{\perp}$ . Barrier between columns higher than between rows  $\rightarrow$  signal-dependent correlation along columns.

Channel stops  
(columns)





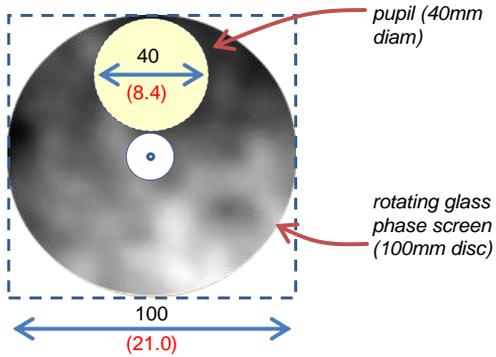
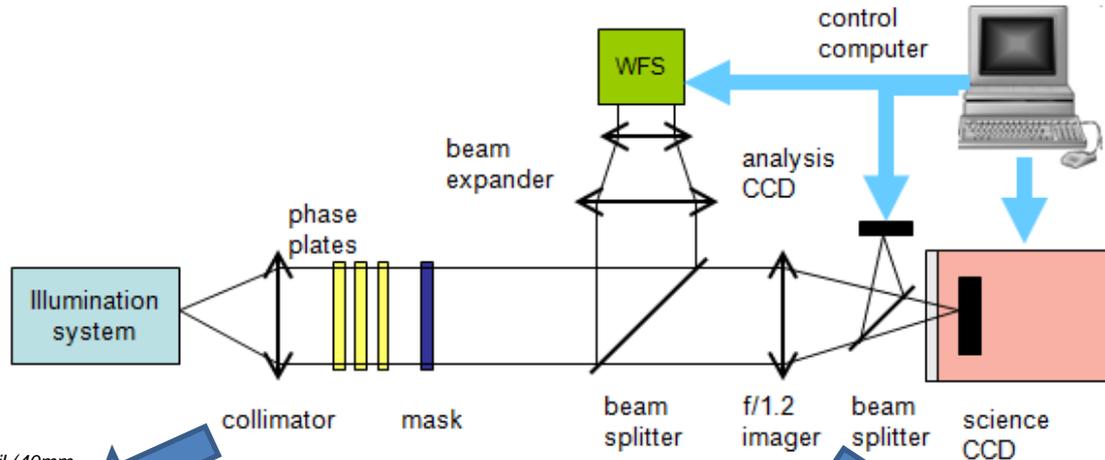
# Spot profile vs. intensity: correlation-induced broadening



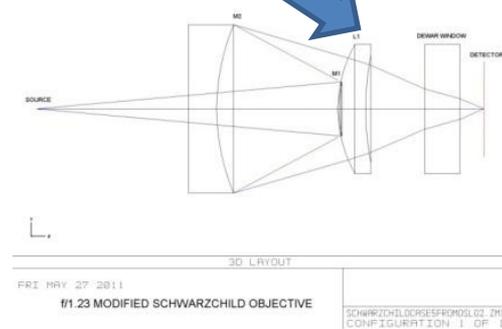
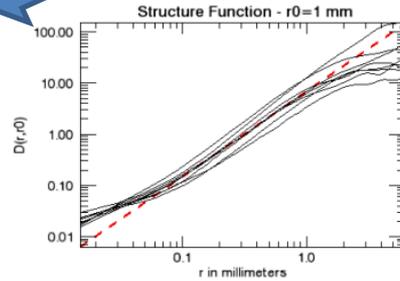
LSST DM might need to parameterize PSF by flux as well as position



# Telescope and atmosphere simulator

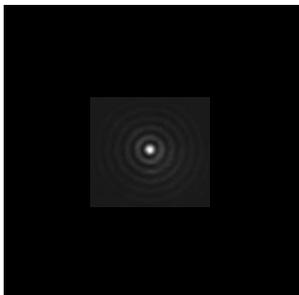


R. Rampy, UCSC

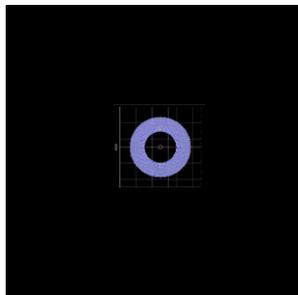


J. Haupt

Focussed – no atmosphere



Defocus – no atmosphere



Wavefront with atmosphere

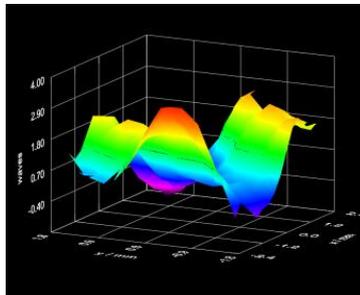
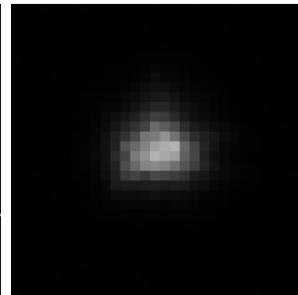
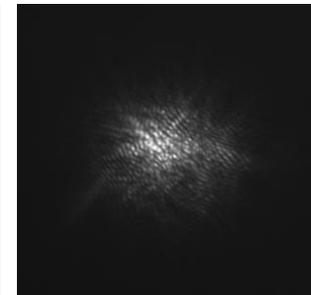


Image with atmosphere



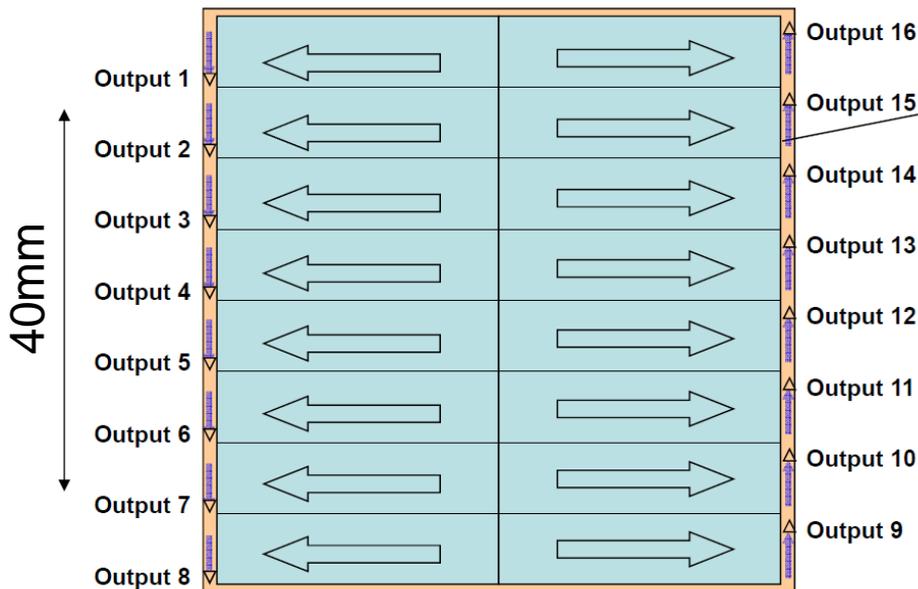
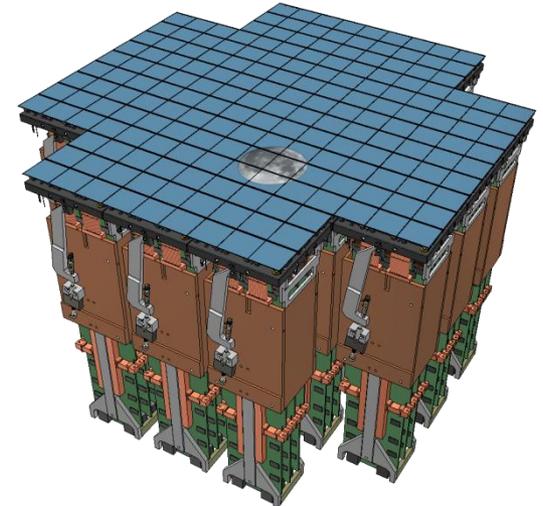
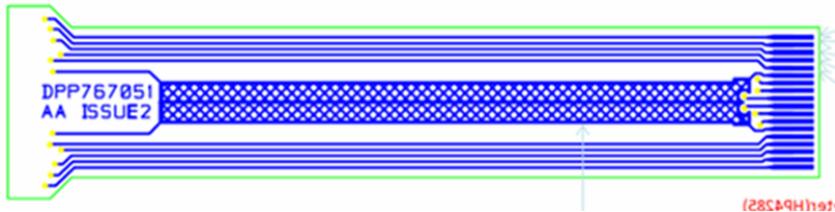
20X re-imaged





# Electronic crosstalk sources

- LSST's 3.2Gpix camera uses fast, compact, and power-constrained readout electronics
  - 2s readout, 550kpix/s
  - Neighboring video signals separated by .25mm
  - 350mW/channel





# How much crosstalk is too much?

**Table 19.12.** Model  $\log N(I)$  (stars per square degree) averaged over galactic longitude and over the whole sky.

$I$	$b = 0$	$b = 5$	$b = 10$	$b = 20$	$b = 30$	$b = 60$	$b = 90$	Sky
12.0	2.466	2.434	2.279	2.011	1.799	1.450	1.374	2.001
13.0	2.922	2.877	2.671	2.355	2.138	1.816	1.728	2.396
14.0	3.316	3.262	3.023	2.678	2.461	2.149	2.045	2.753
15.0	3.650	3.594	3.344	2.991	2.772	2.445	2.326	3.075
16.0	3.951	3.897	3.653	3.301	3.069	2.702	2.575	3.376
17.0	4.243	4.191	3.955	3.594	3.341	2.926	2.799	3.663
18.0	4.548	4.494	4.247	3.861	3.584	3.133	3.005	3.947
19.0	4.868	4.807	4.530	4.103	3.804	3.327	3.191	4.230
20.0	5.191	5.120	4.802	4.326	4.005	3.503	3.353	4.510
21.0	5.479	5.398	5.039	4.515	4.173	3.649	3.488	4.761
22.0	5.710	5.623	5.234	4.673	4.313	3.770	3.604	4.967
23.0	5.909	5.816	5.400	4.806	4.430	3.874	3.706	5.145
24.0	6.092	5.991	5.546	4.916	4.528	3.970	3.797	5.308
25.0	6.258	6.150	5.669	5.002	4.606	4.055	3.875	5.453

$5\sigma$  limiting magnitude is  $r=24.2$

If crosstalk spec is  $x$

$\rightarrow r < (24.2 + 2.5 \log(x))$  source will produce detectable crosstalk ghost

How many stars/CCD will produce detectable ghosts?

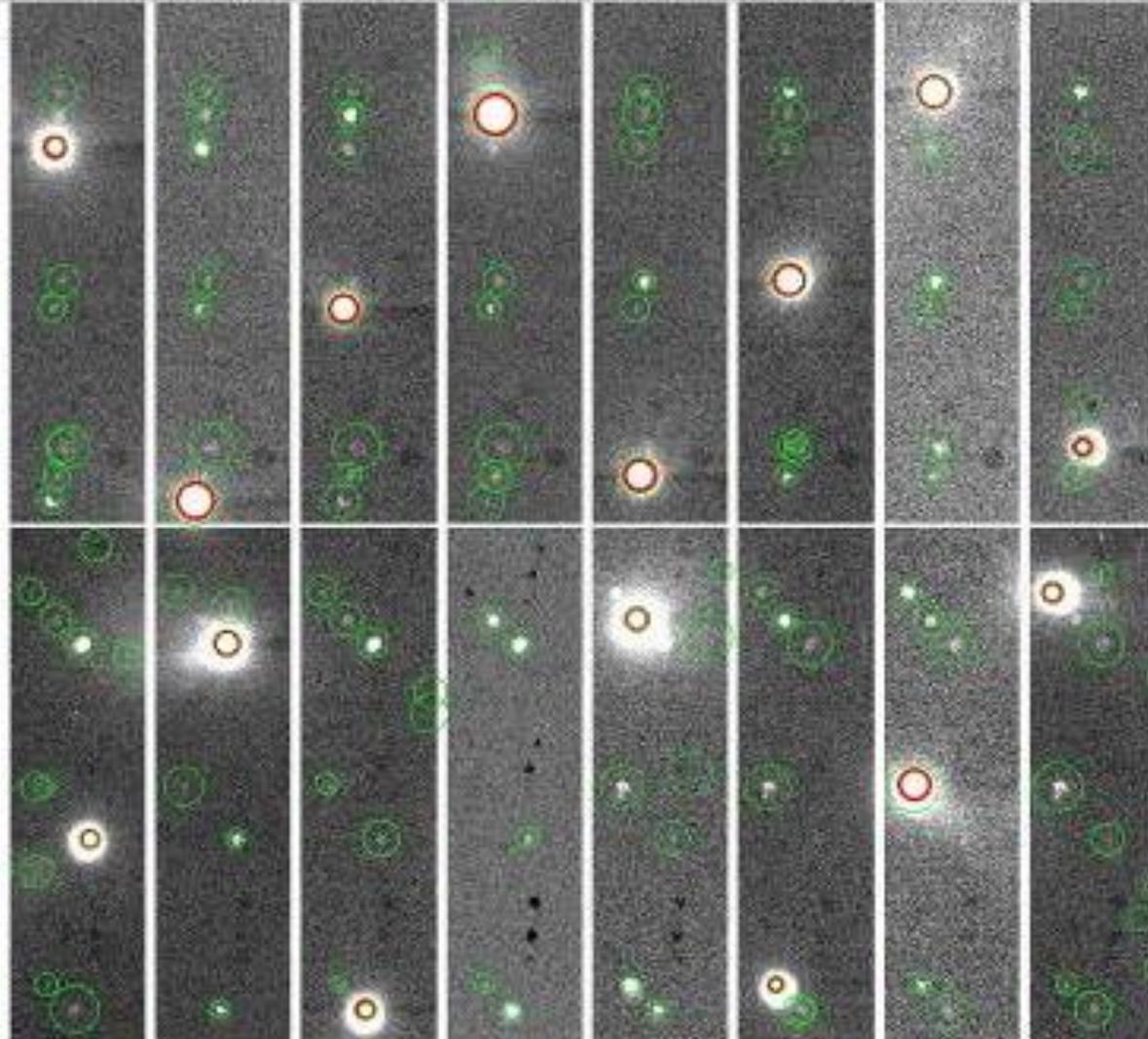
	crosstalk level			
	0.2%	0.07%	0.02%	0.004%
$I$	17.5	16.3	14.95	13.2
$\log(N(I))$	3.8	3.4	3.08	2.45
$10^{(N(I))} \cdot (14/60)^2$	344	137	65	15



# Crosstalk measurement using multi-aggressor mask

100 coadded images with identified aggressors (red) and victims (green)

Aggressors peak amplitude  $\sim 35,000 e^-$       Background noise level  $\sim 1.2 e^-$

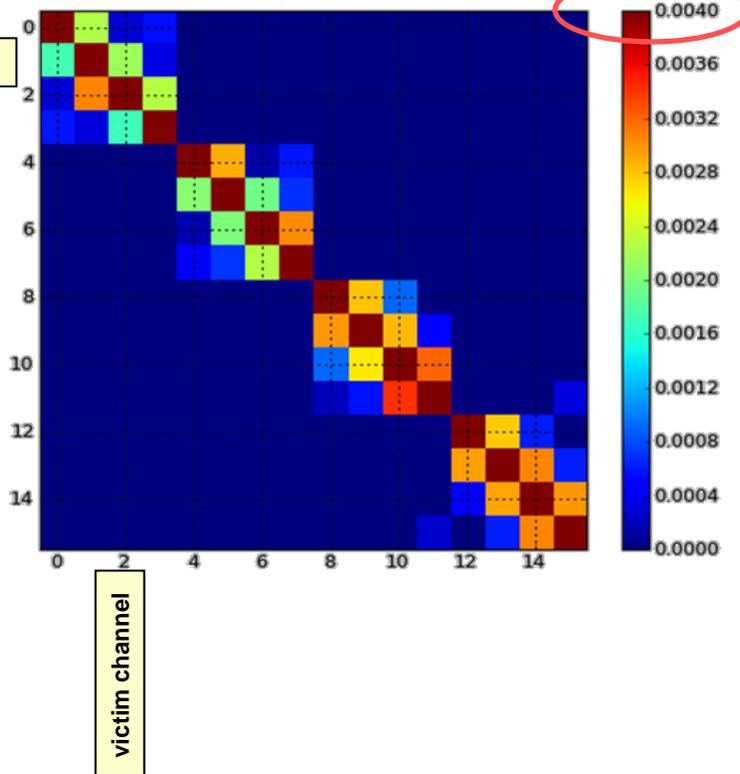


*SExtractor finds over 100 "victims" down to  $10^{-5}$*

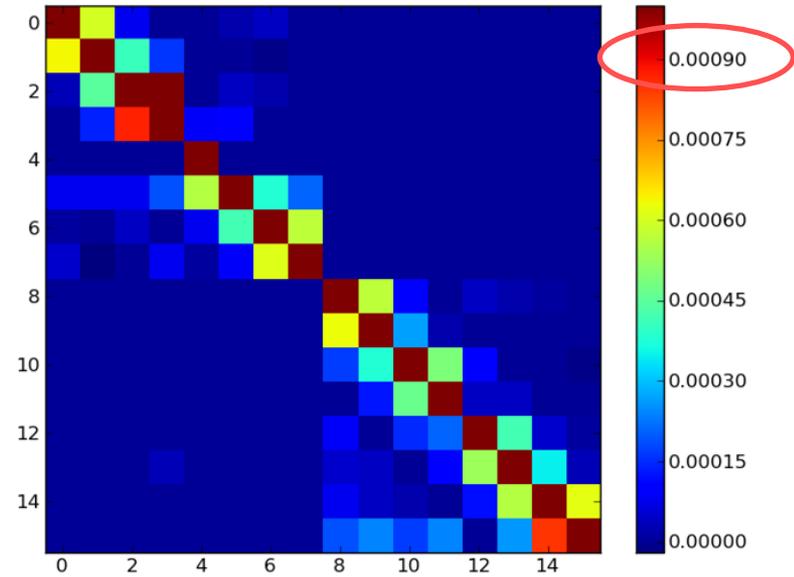


# 16 x 16 crosstalk matrix

With test cabling 326mm

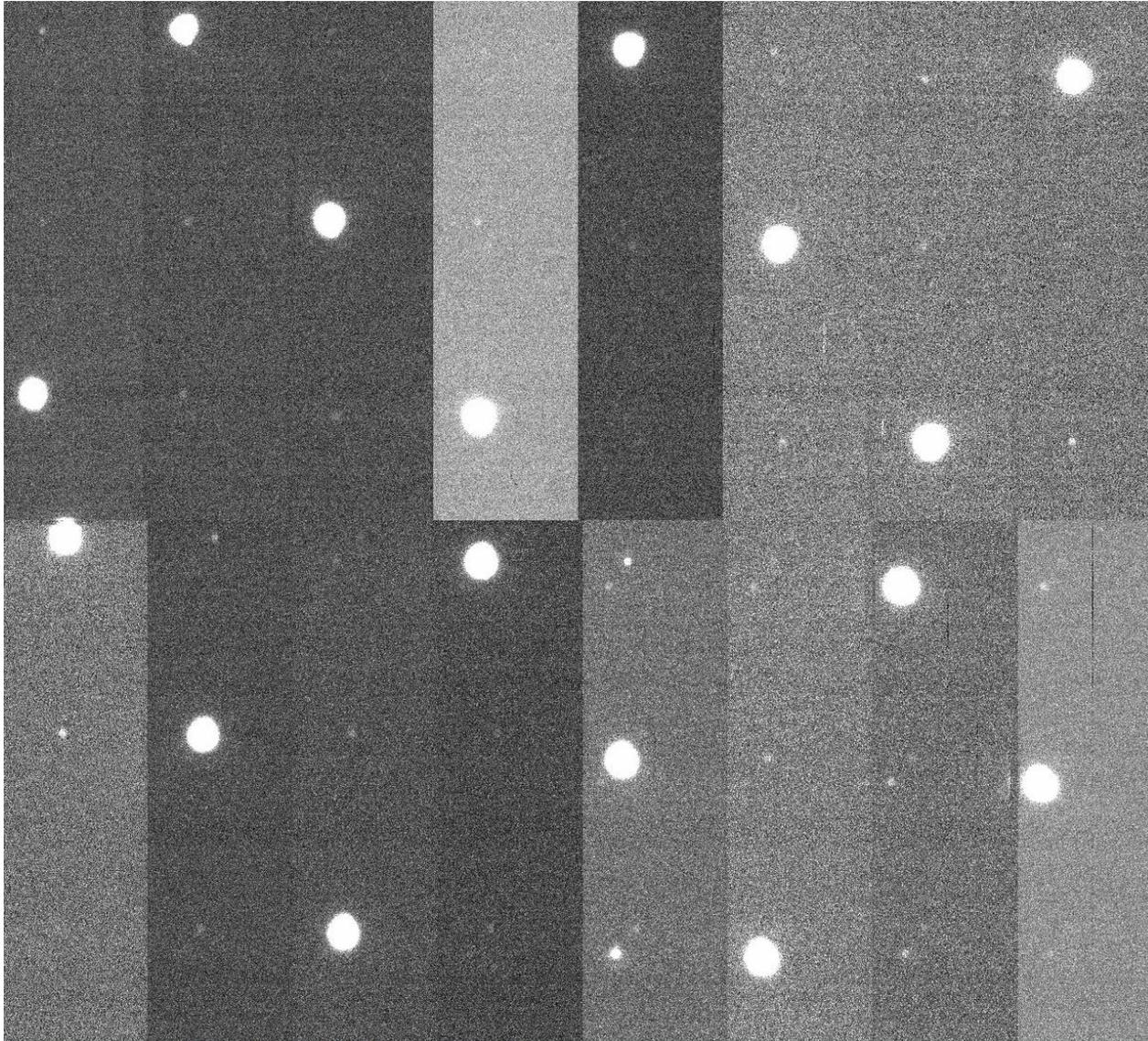


With system cabling 67mm



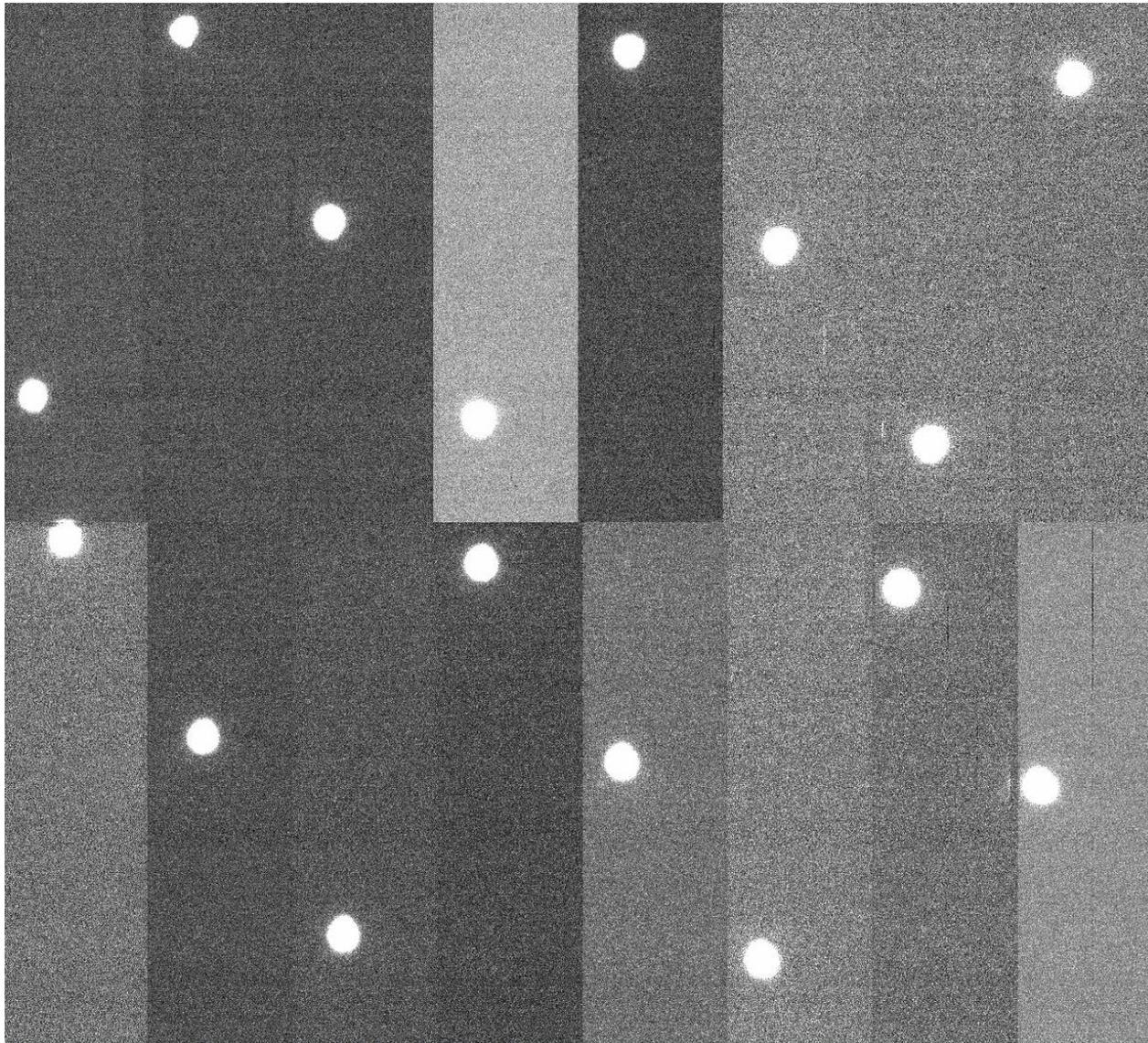


# Crosstalk before correction (no coadd, $\sim 11e^-$ noise)





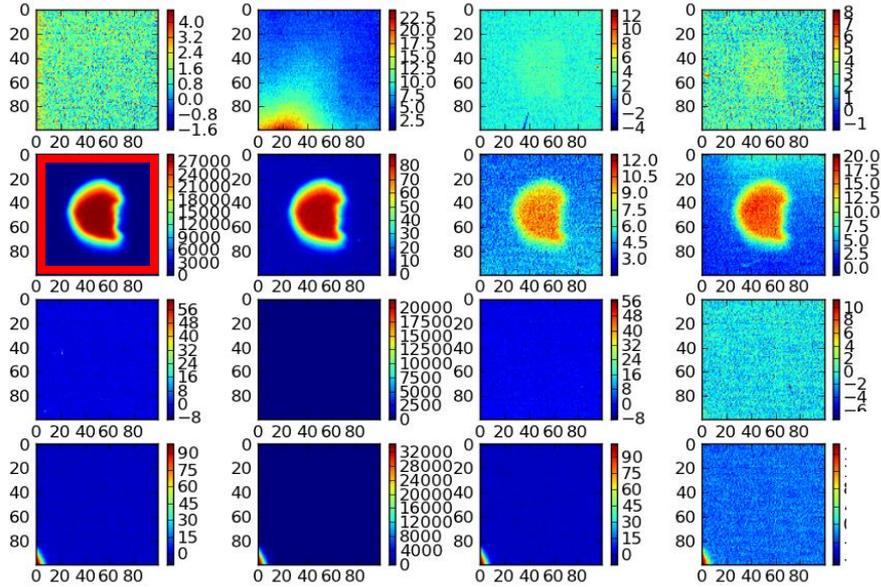
# Crosstalk after correction (no coadd, $\sim 11e^-$ noise)



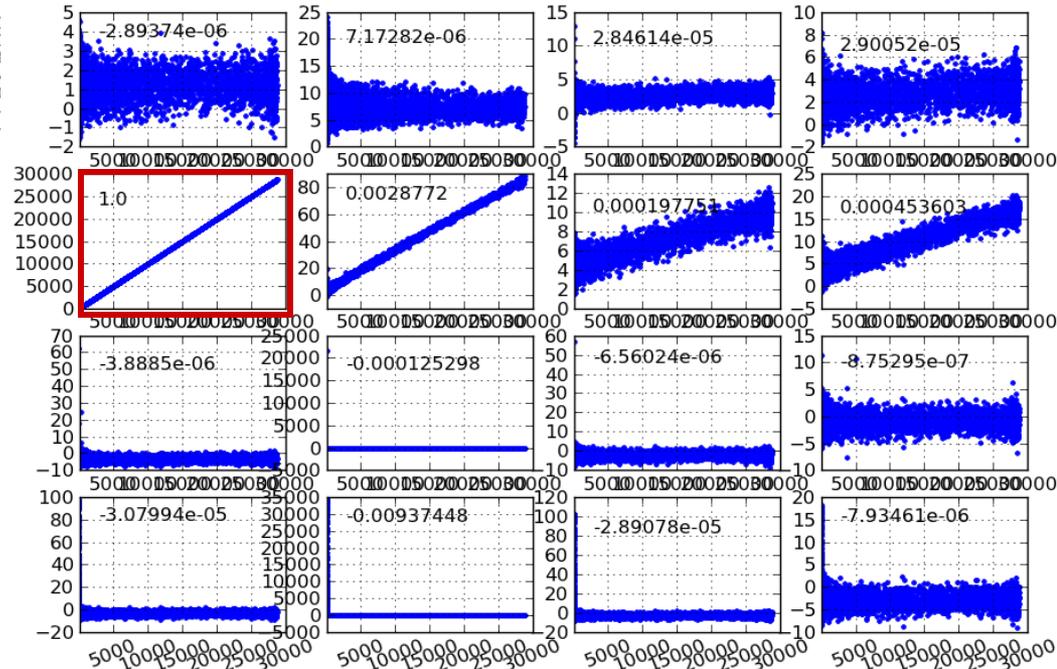


# Crosstalk linearity check

aggressor in segment 5



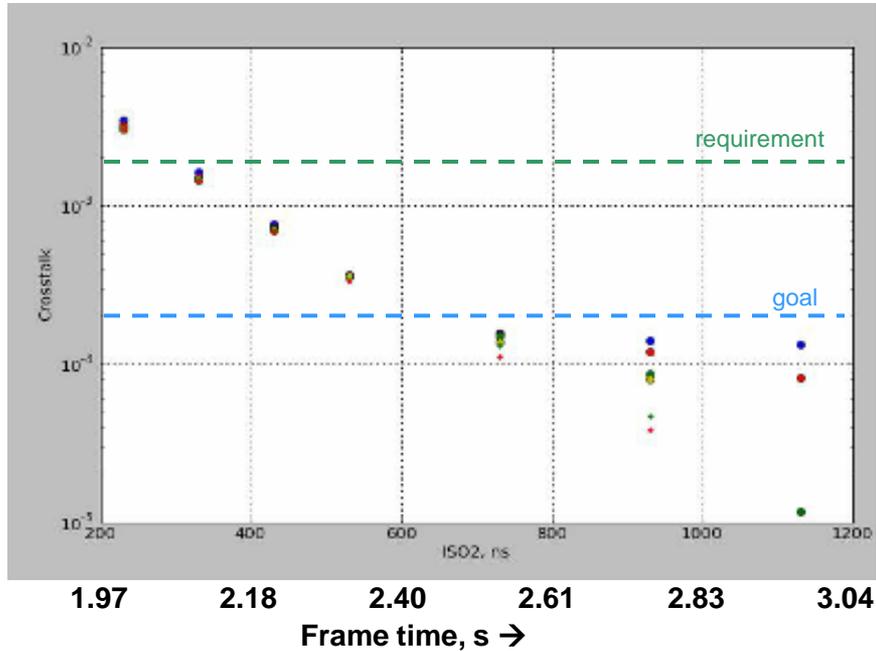
plot pixel-by-pixel counts in victim channels vs. corresponding aggressor pixel



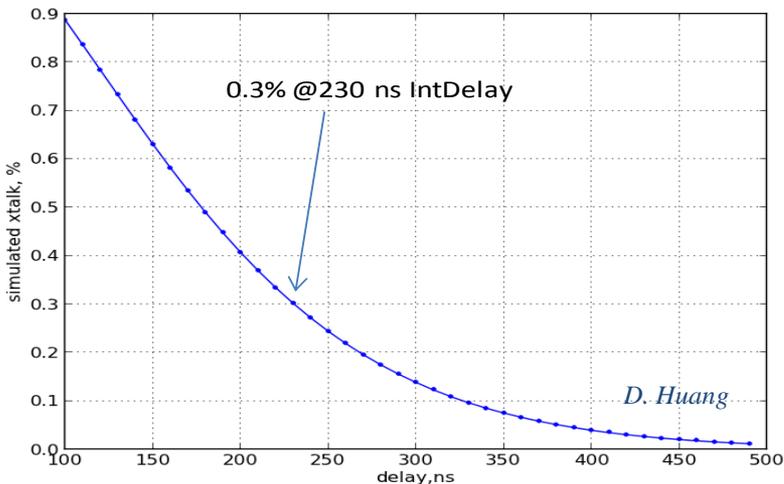


# CCD250 crosstalk vs. pixel timing and drive current

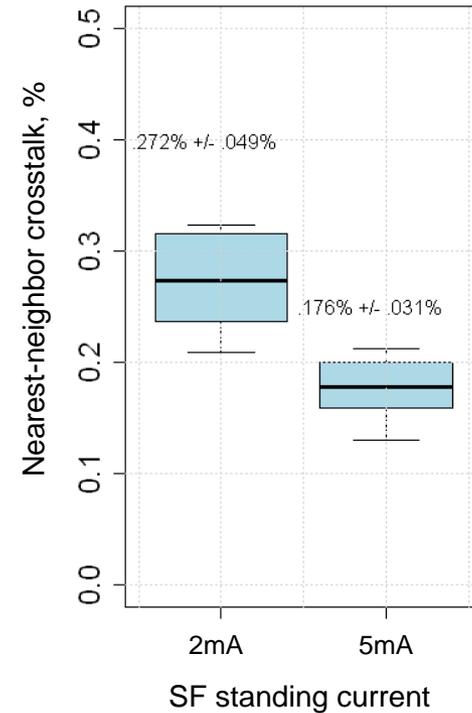
Crosstalk vs. video CDS window delay (with test cabling)



SPICE simulation



Crosstalk vs. output source follower bias current

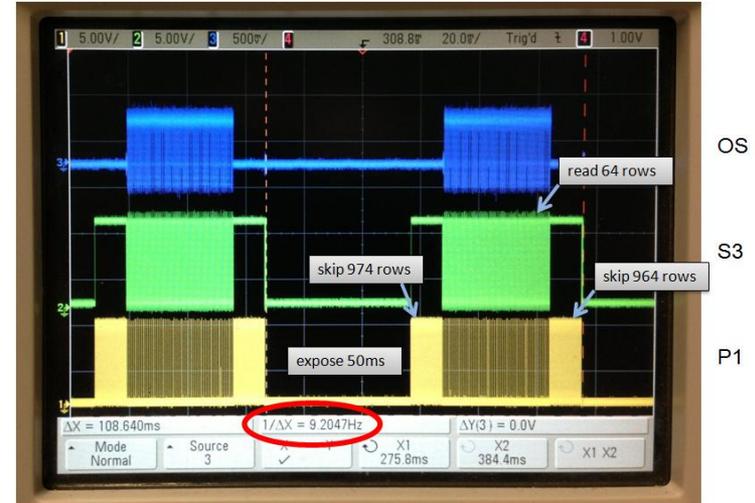
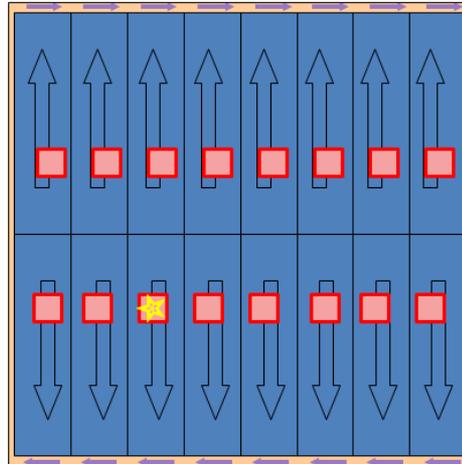


- Increasing  $I_{bias}$  reduces output impedance and increases transconductance by  $\sim 1/\sqrt{I_{bias}}$
- Crosstalk and noise reductions seen are consistent (crosstalk 55% lower, noise 17% lower)



# Using the science CCD as a guider

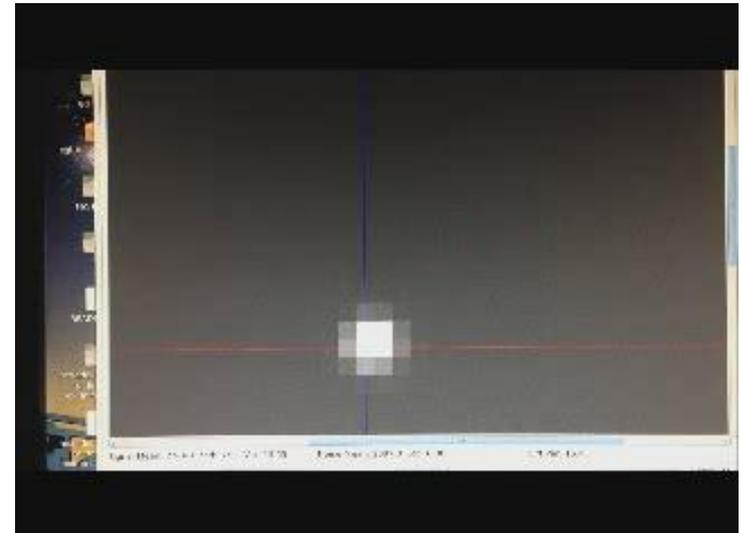
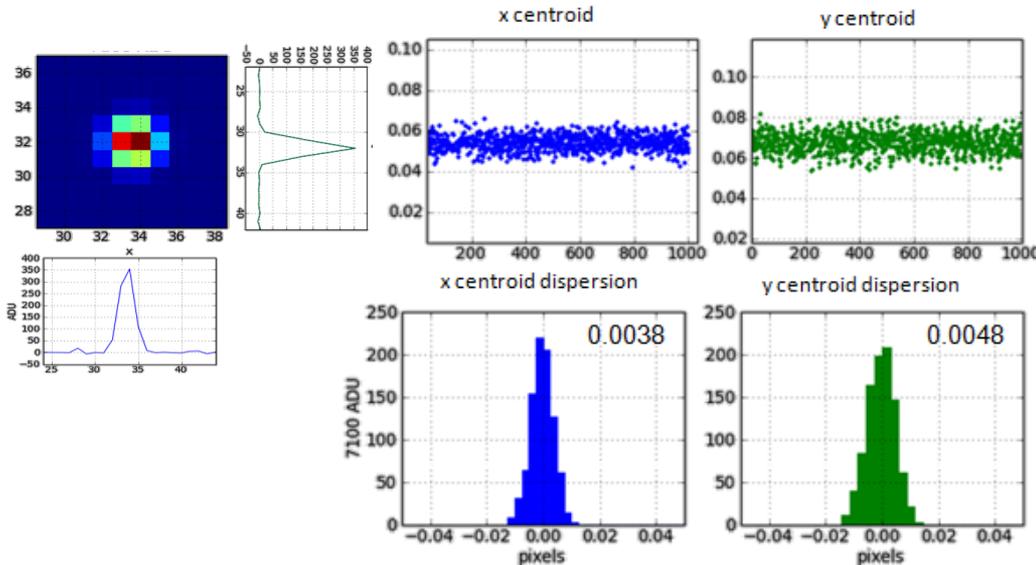
- 4 CCDs in corners of FP to be used for telescope guiding loop
- require 9Hz readout of 50x50 pixel ROI
- centroid noise < 0.2 pixels



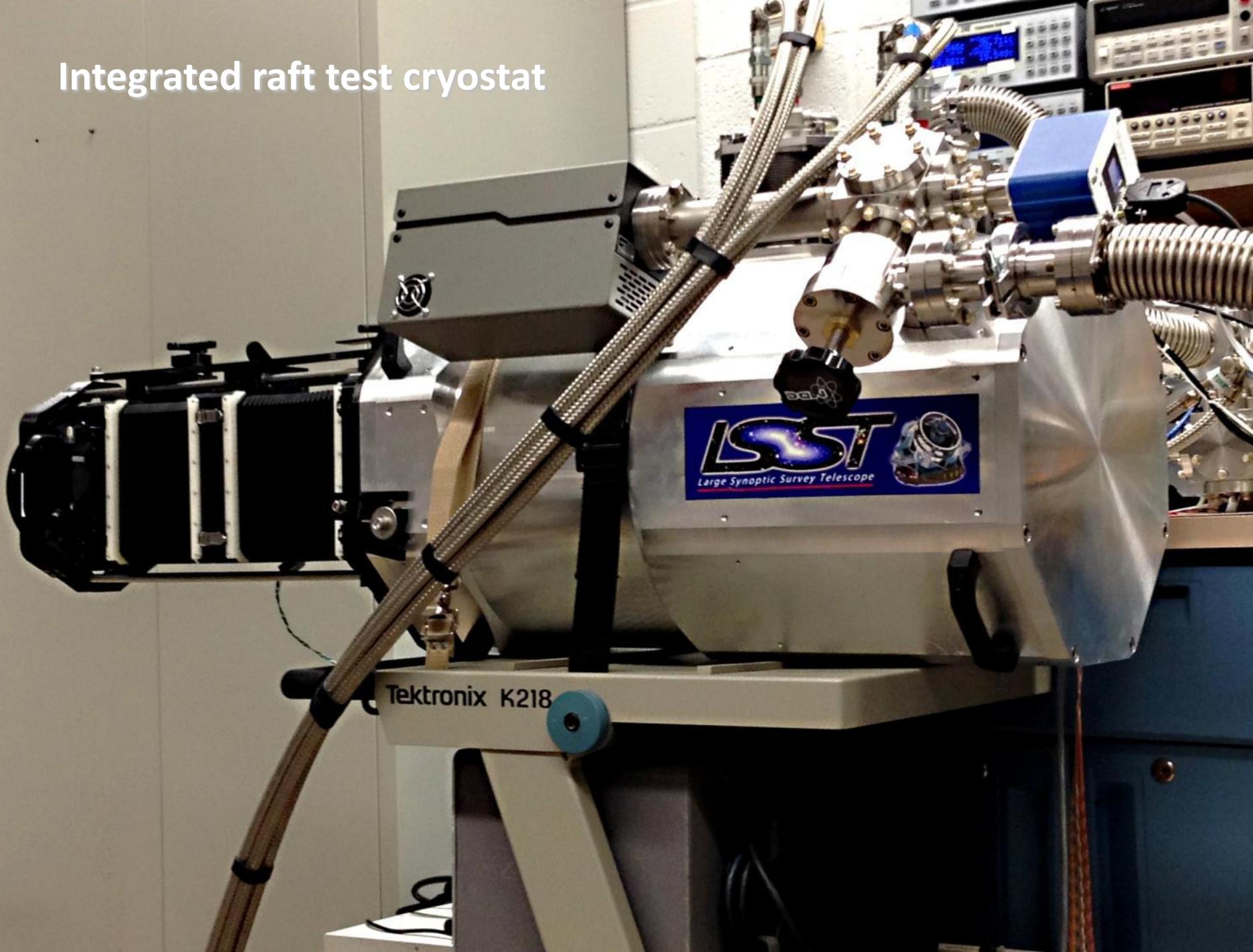
OS  
S3  
P1

*I. Kotov*

test with focused spot, prototype CCD, Reflex controller

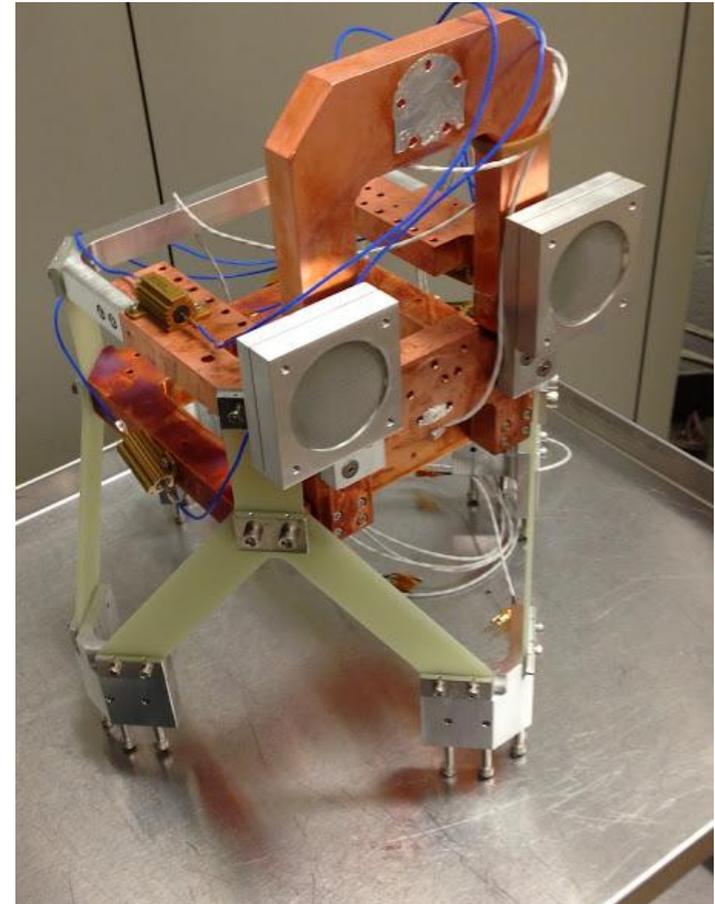
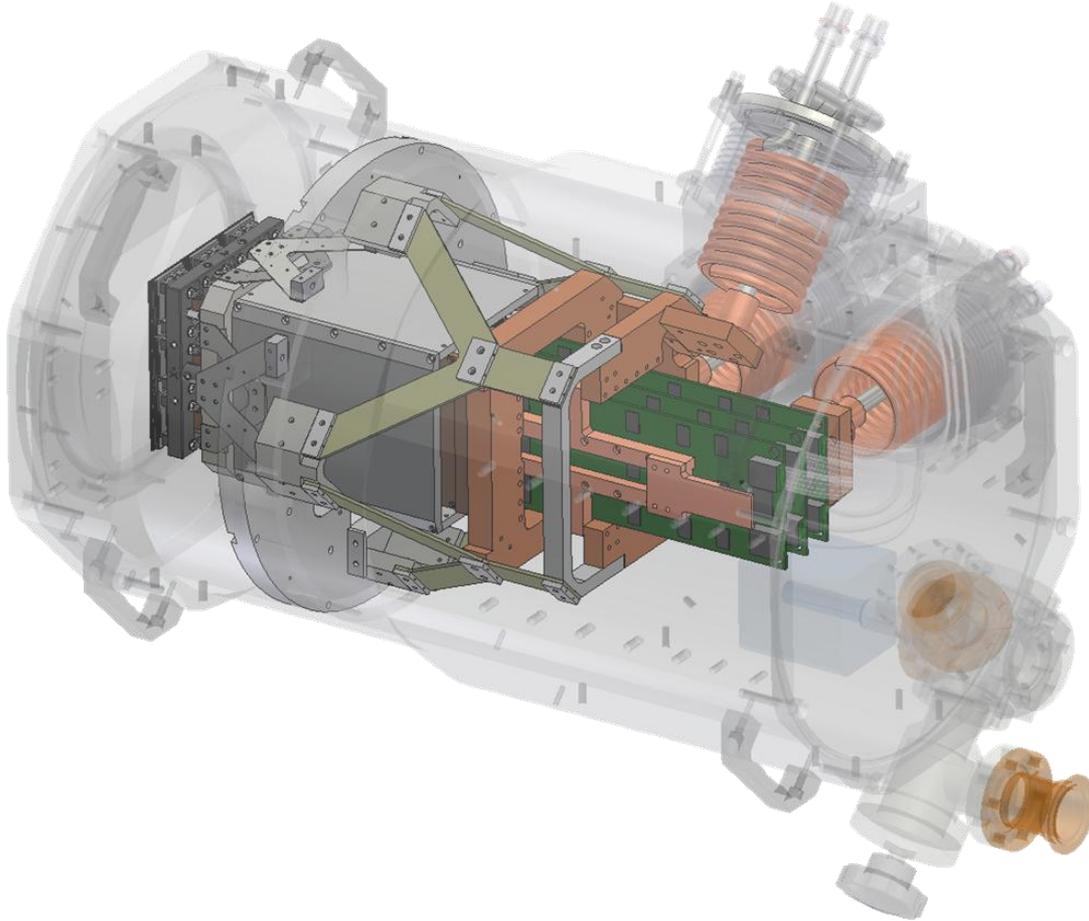


# Integrated raft test cryostat





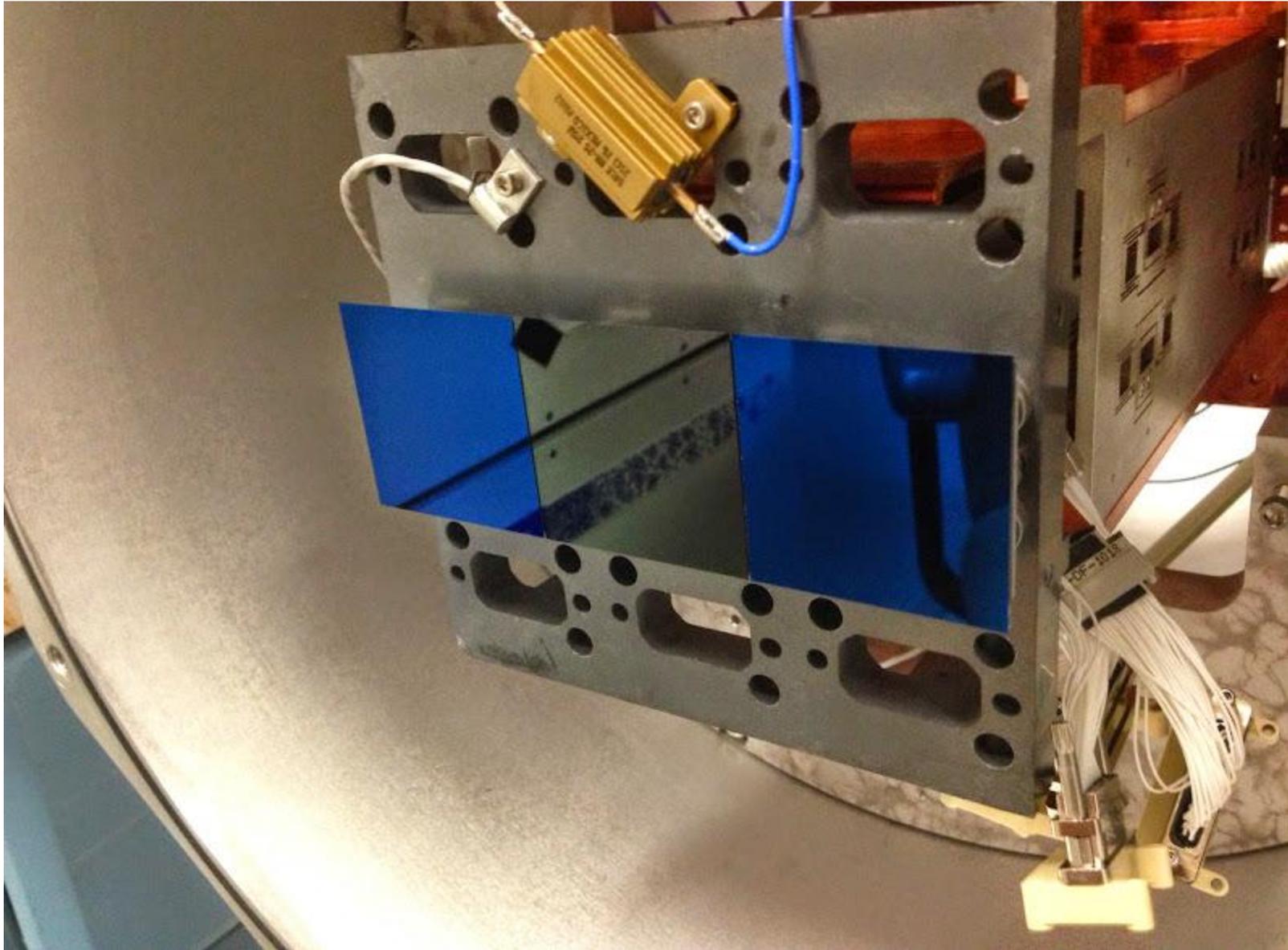
# Camera details - internal



*J. Haupt  
G. Fraser*

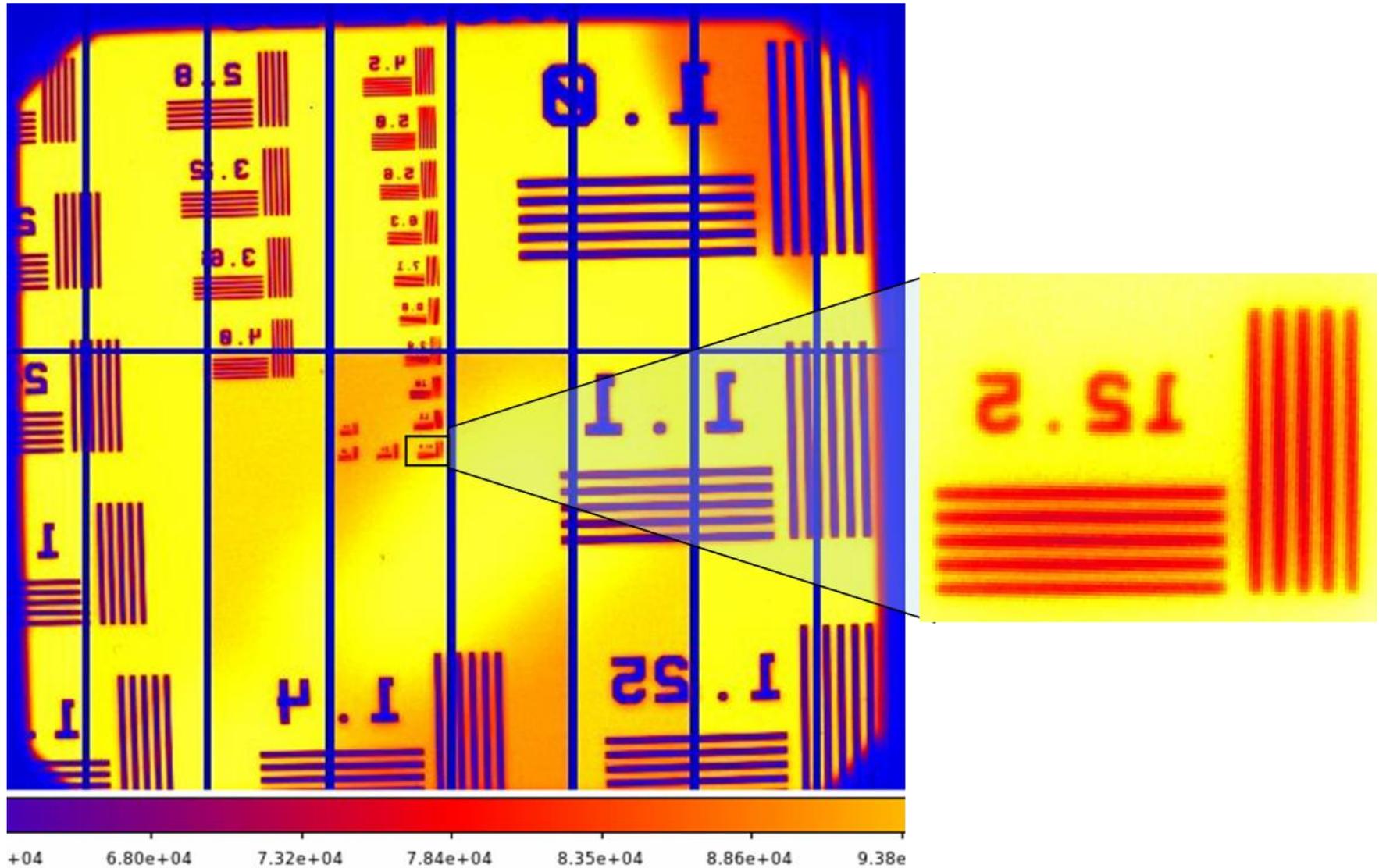


3 engineering-grade CCDs installed on SiC baseplate,  
in cryostat, connected to REB





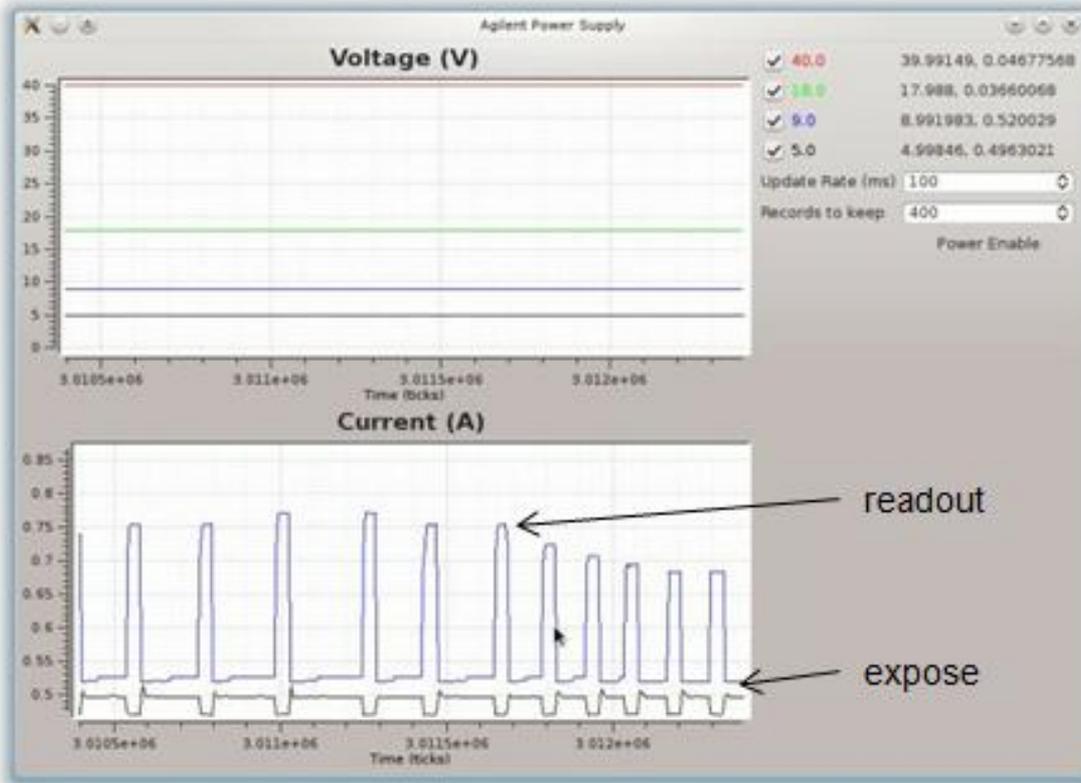
# First light





# Signal-dependent power consumption

Current vs. time reading flatfields

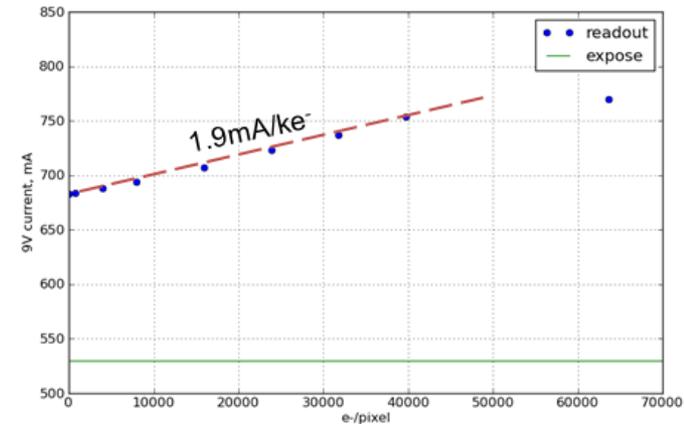


high signal

intermediate

zero signal

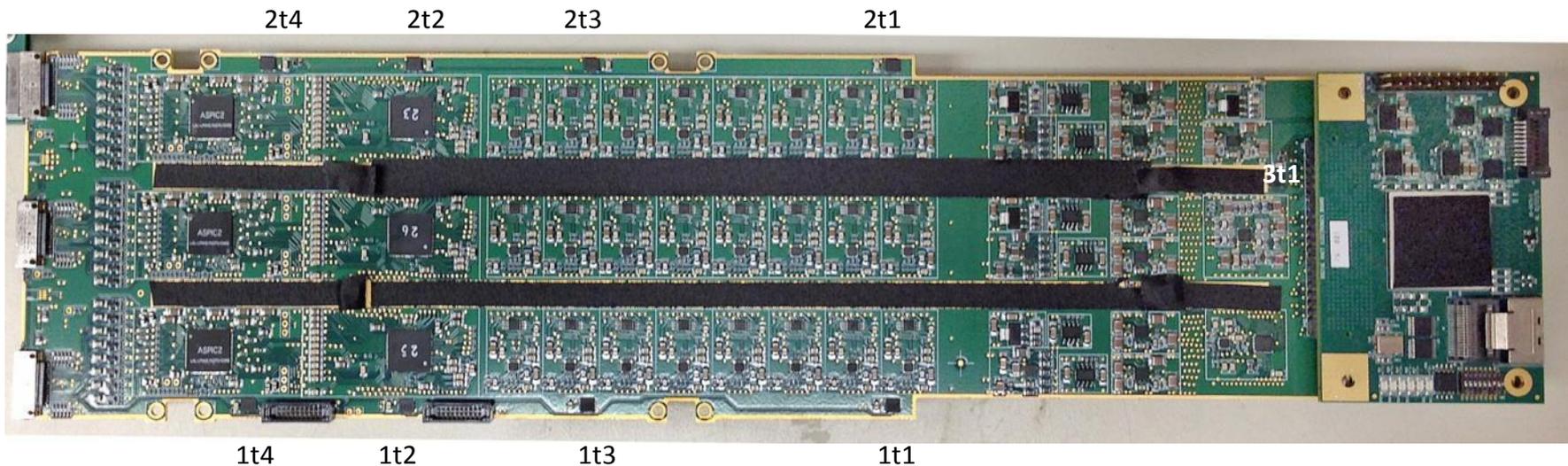
*J. Kuczewski*





# REB thermal profile

Location of temperature sensors on REB



Measurements on 1-stripe REB:

	A	B	C	E	G	H
1	Temperatures			Temperature relative to Cold Plate		
2	Date	3-13 18:43	3-14 15:31		3-13 18:43	3-14 15:31
3	CP	-20.64	-40		0	0
4						
5	2t3	-14.69	-34.13		5.95	5.87
6	2t2	-14.88	-34.32		5.76	5.68
7	2t1	-13.75	-33		6.89	7
8	2t4	-15.125	-34.44		5.515	5.56
9	3t1	-7.438	-26.25		13.202	13.75
10	1t1	-14.5	-33.19		6.14	6.81
11	1t2	-15.19	-33.81		5.45	6.19
12	1t3	-27.13	-42.81		-6.49	-2.81
13	1t4	-17.5	-35.56		3.14	4.44
16						

- Video components within 4°C
- Back end of board 7°C warmer
- REB temperatures move with cold plate
- Thermal transients under study



## Summary

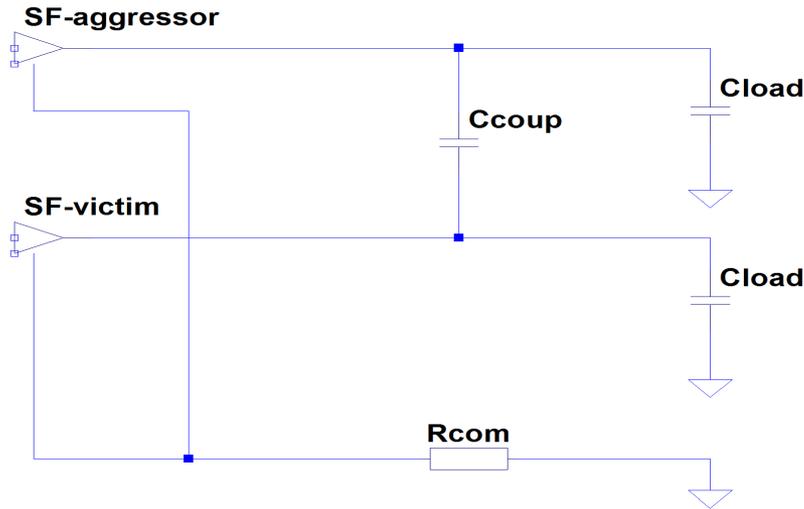
- LSST project is entering the construction phase after  $\sim 10$  years of R&D
- BNL is responsible for delivering the critical components of the camera focal plane
- R&D investigations on thick, fully depleted CCDs link sensor behavior to science
- A flexible platform for system integration tests has been developed at BNL and is the prototype for production acceptance tests and the LSST commissioning camera



BACKUP

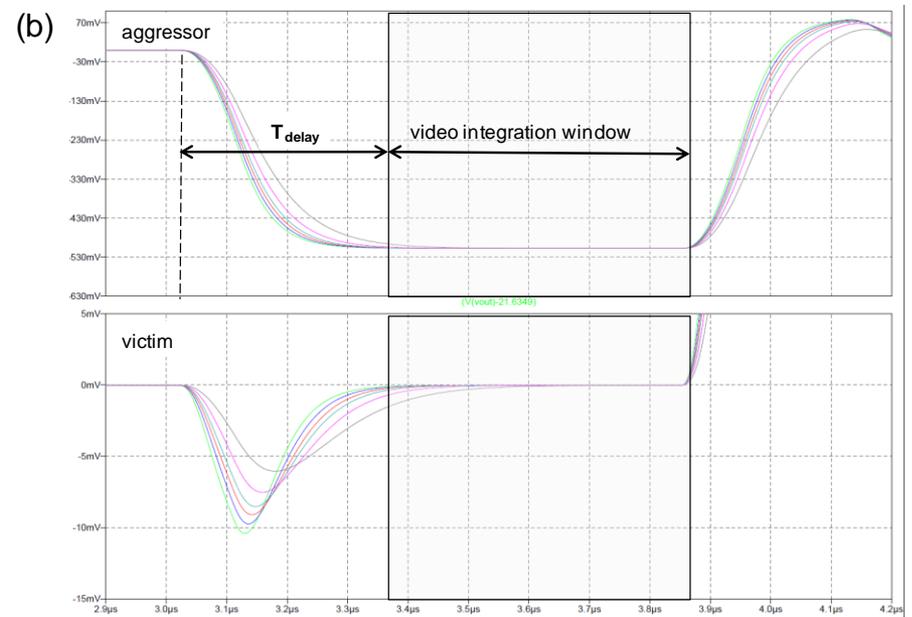
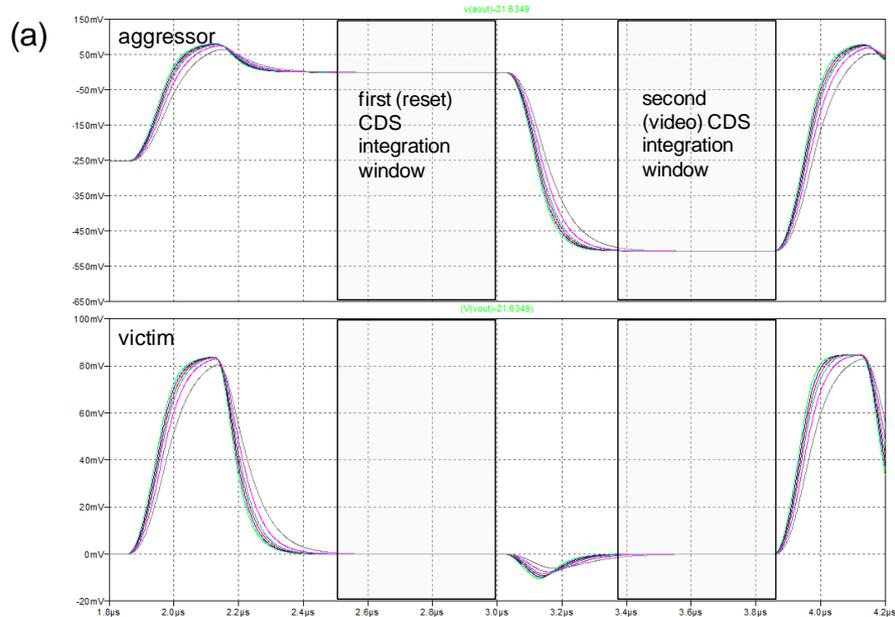


# Simplified circuit model



$$C_{coup} = 2.8 \text{ pF}$$

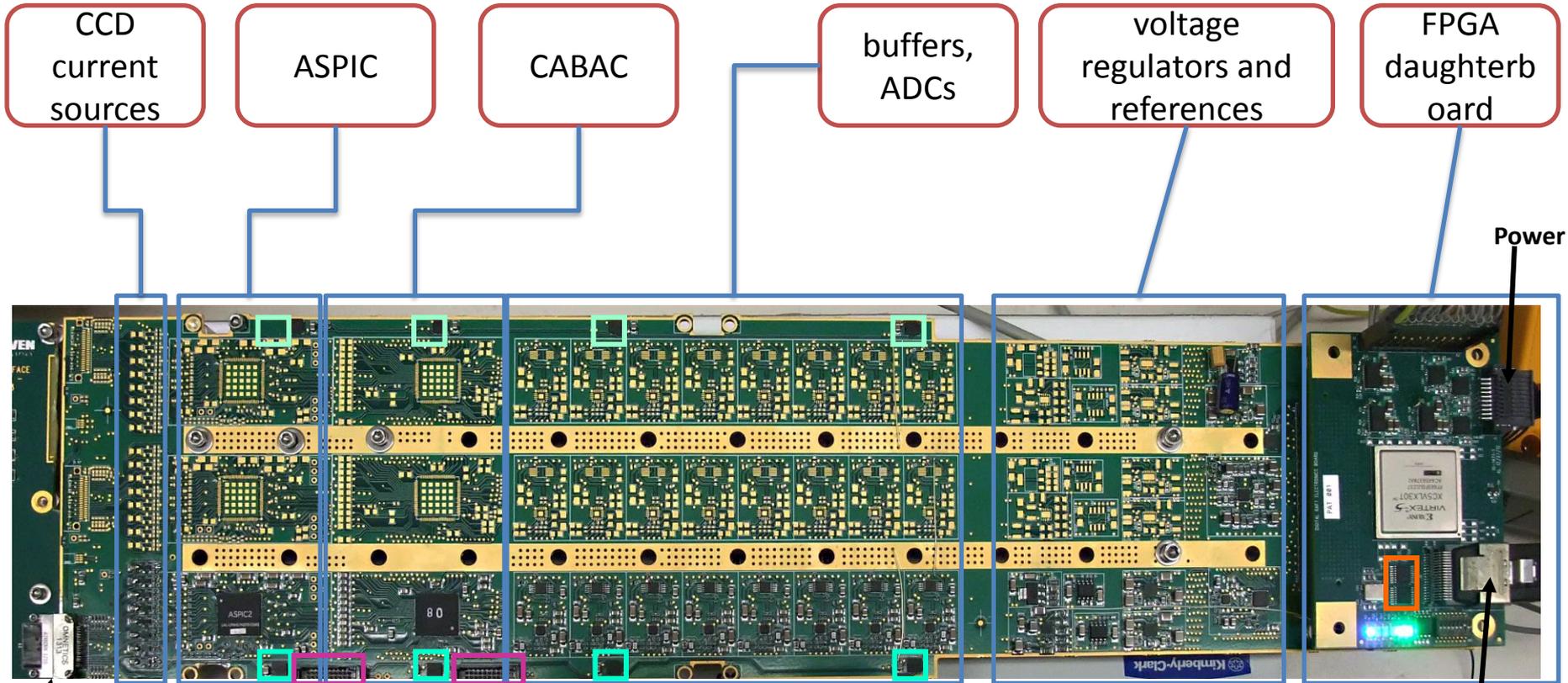
$$C_{load} = 5, 10, 15, 20, 30, 50 \text{ pF}$$





# raft electronics board (REB)

STRIPE 1 POPULATED

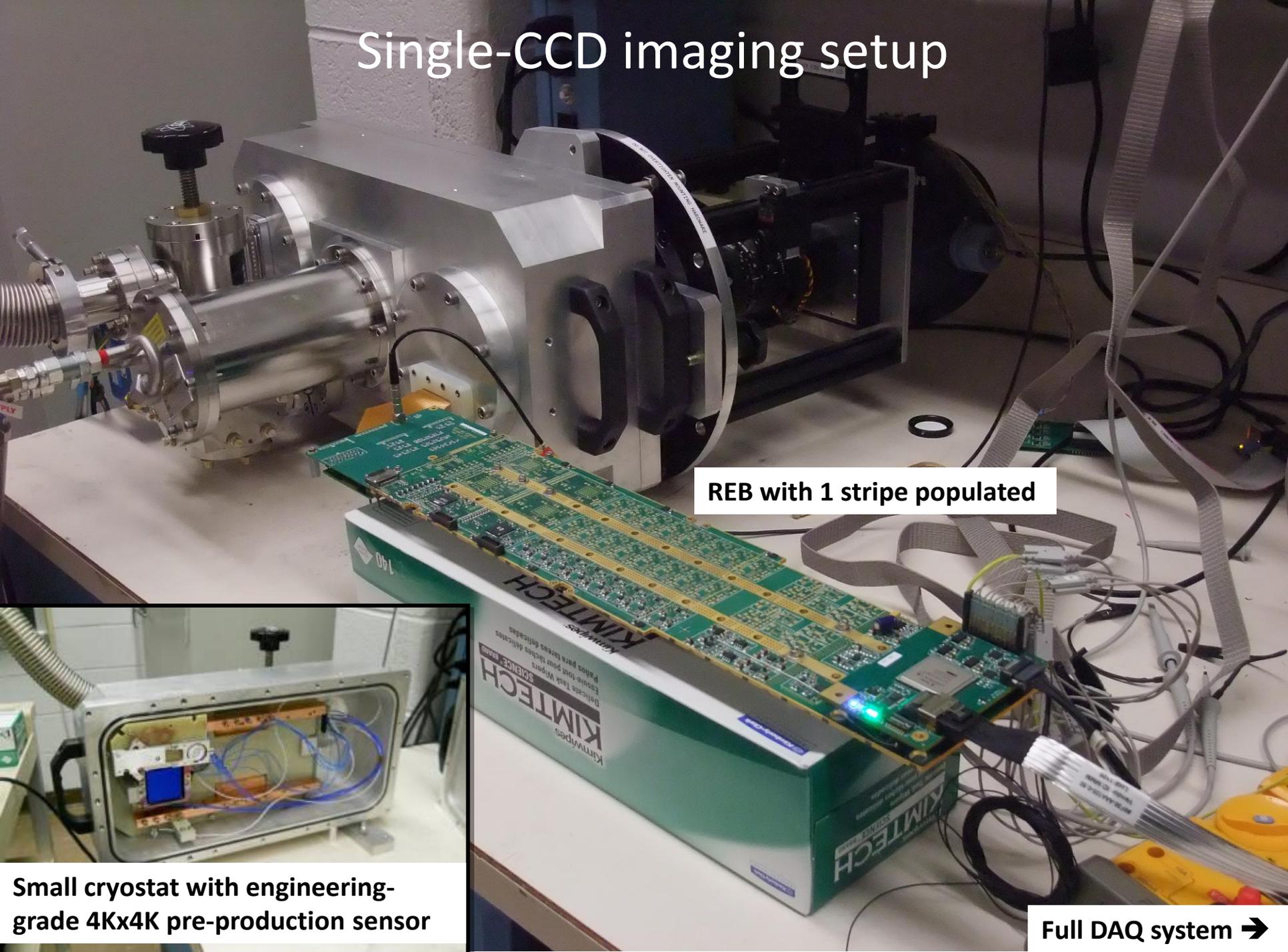


CCD connector

- Board temperature monitor
- Supply current and voltage monitor
- Test connector

HS serial I/O

# Single-CCD imaging setup



REB with 1 stripe populated



Small cryostat with engineering-grade 4Kx4K pre-production sensor

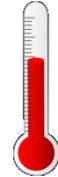
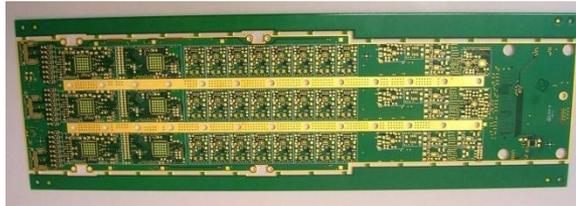
Full DAQ system →



# Next steps

1 REB only

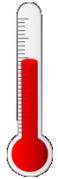
Pulser/  
Emulator



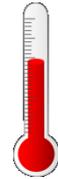
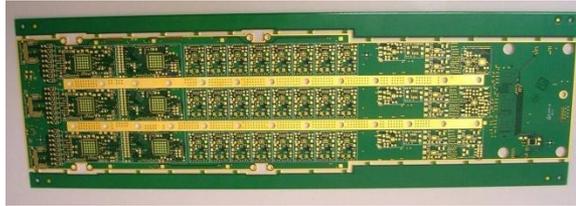
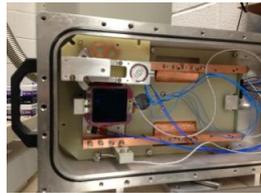
25°



1 REB warm +  
1 CCD



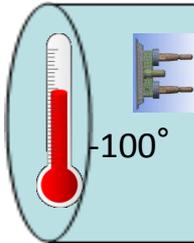
-100°



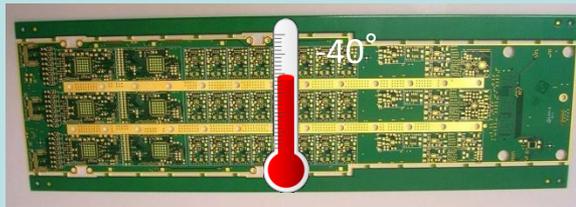
25°



1 REB + 1 CCD in  
cryostat



-100°

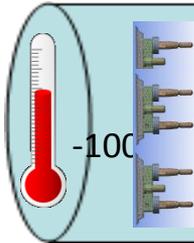


-40°

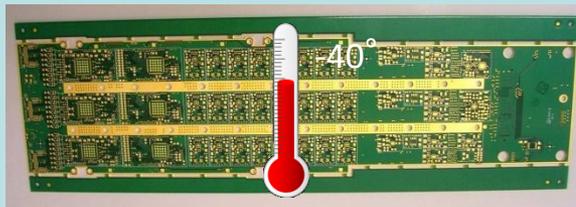
VAC  
-  
OTM



1 REB + 3 CCDs in  
cryostat



-100°

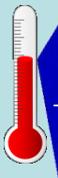
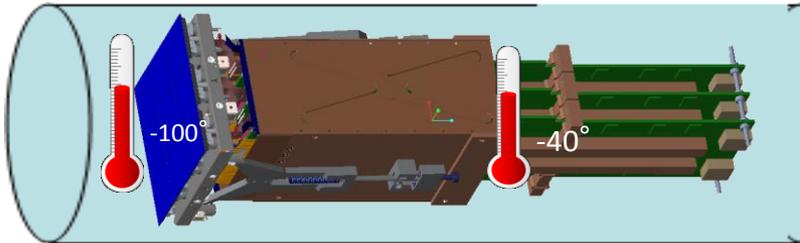


-40°

VAC  
-  
OTM



Full RTM: 9 CCDs, 3  
REBs



-100°



-40°

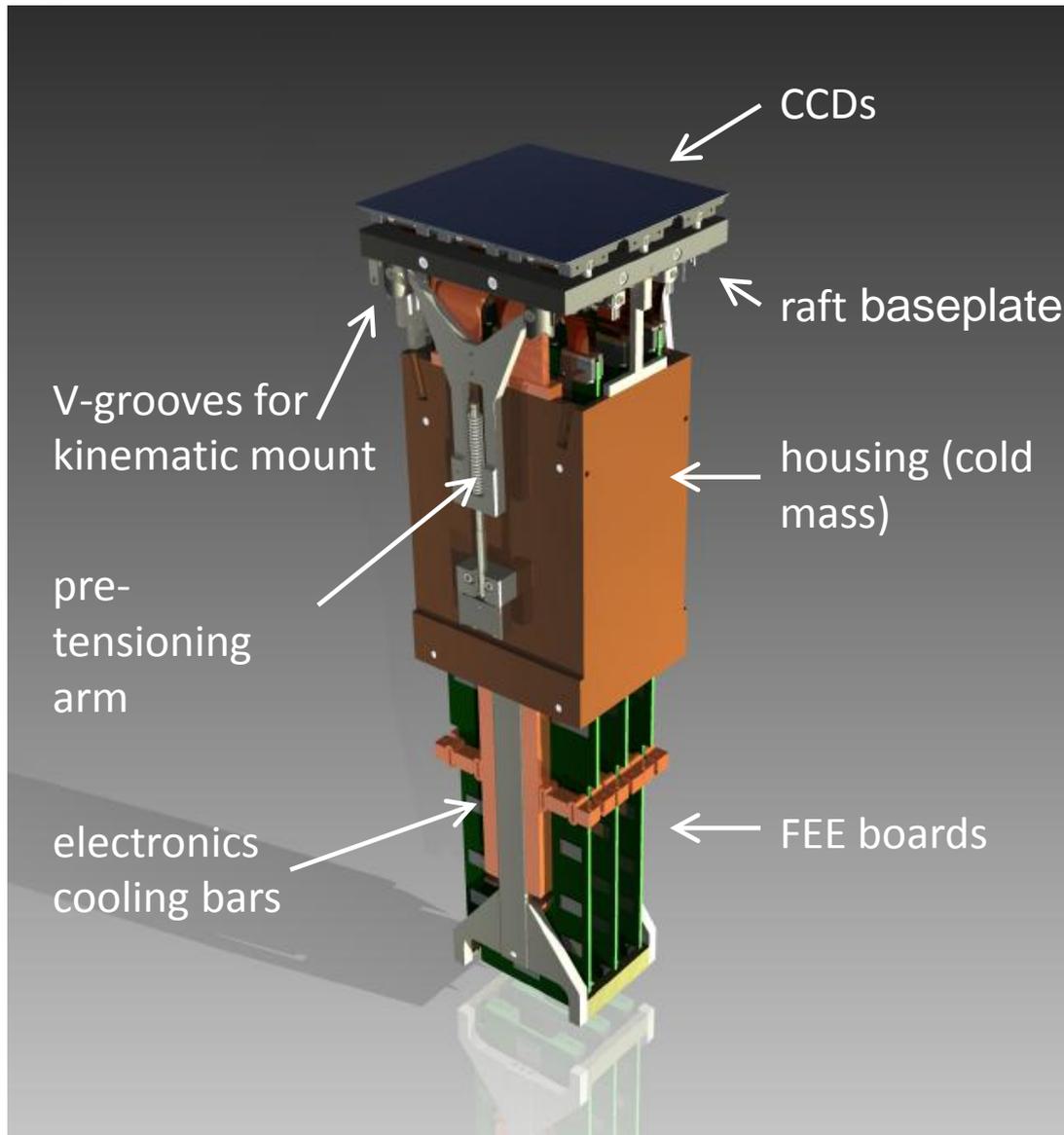
VAC  
-  
OTM



TCM



# Raft Tower Module



Complete 144-Mpixel imager  
Support sensors mechanically to meet strict coplanarity and piston tolerances

Thermal management of sensors and electronics

Protect sensor surfaces from condensable contamination

Provide bias, timing, and control signals for CCD operation

Low noise analog signal processing

Digitizing, multiplexing of pixel data

Diagnostics and slow controls

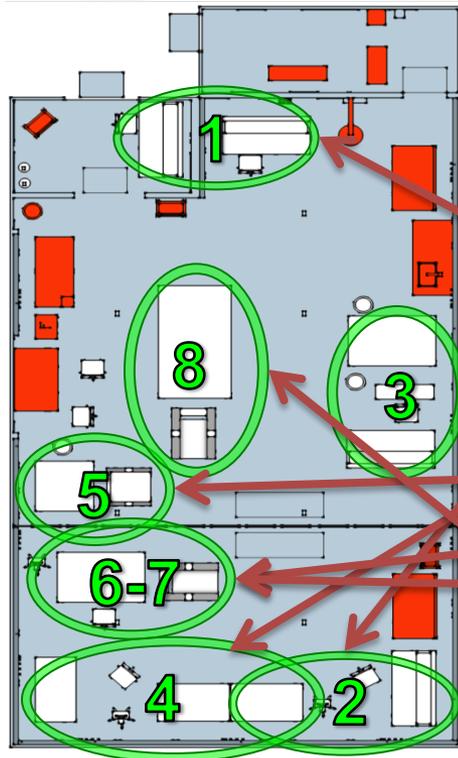
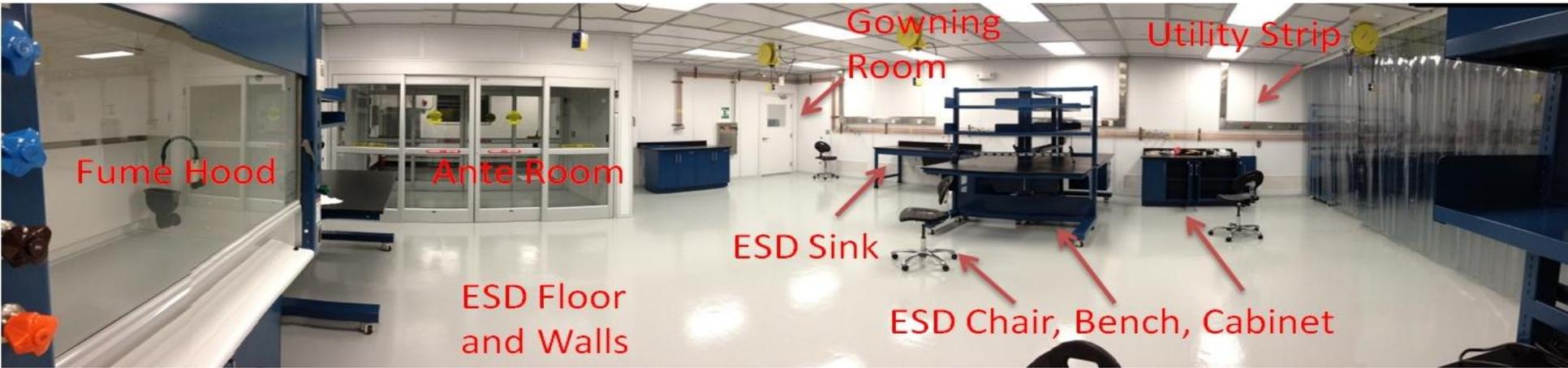
Optimized for

— *Compactness*

— *Low power*



# System Description (2): Cleanroom, assembly and testing support



- TS1 - Receiving & Inspection
- TS2 - Initial Metrology
- TS3 - Sensor EO Characterization
- TS4 - Sensor Out of Jig Metrology/RSA Integration
- TS5 - RSA/Science Raft Warm/Cold Metrology
- TS6 - Science Raft Assembly
- TS7 - Science Raft Dewar Integration
- TS8 - Science Raft EO Testing

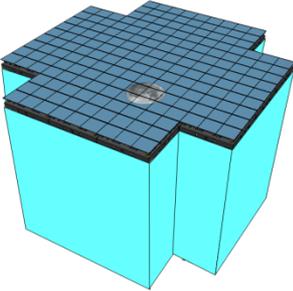


# P. O'Connor – LSST integrated readout: design



## The problem

- Electronics to **control CCDs** and **process an aggregate of 1.5Gpixels/s** must fit into 1/6m<sup>3</sup> behind the focal plane
- Inclusive of thermal and mechanical FPA support
- **Everything in cryostat**



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## The solution

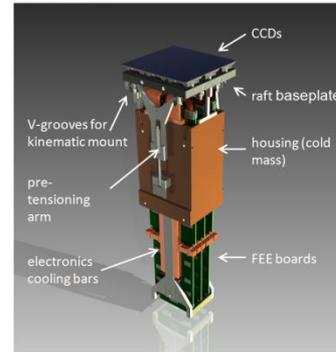
- A modular system of 21 “raft towers”.
- Each is an autonomous, fully-testable 12K x 12K imager.
- Roughly the same size and power envelope as a 16-channel SDSU controller.
- Keys to compactness and low power:
  - Shortest possible CCD-electronics interconnect length
  - Analog CDS
  - ASIC-based clock, bias, and video processing



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## Raft Tower Module



- Complete 144-Mpixel imager
- Support sensors mechanically to meet strict coplanarity and piston tolerances
- Thermal management of sensors and electronics
- Protect sensor surfaces from condensable contamination
- Provide bias, timing, and control signals for CCD operation
- Low noise analog signal processing
- Digitizing, multiplexing of pixel data
- Diagnostics and slow controls

- Optimized for
- Compactness
  - Low power

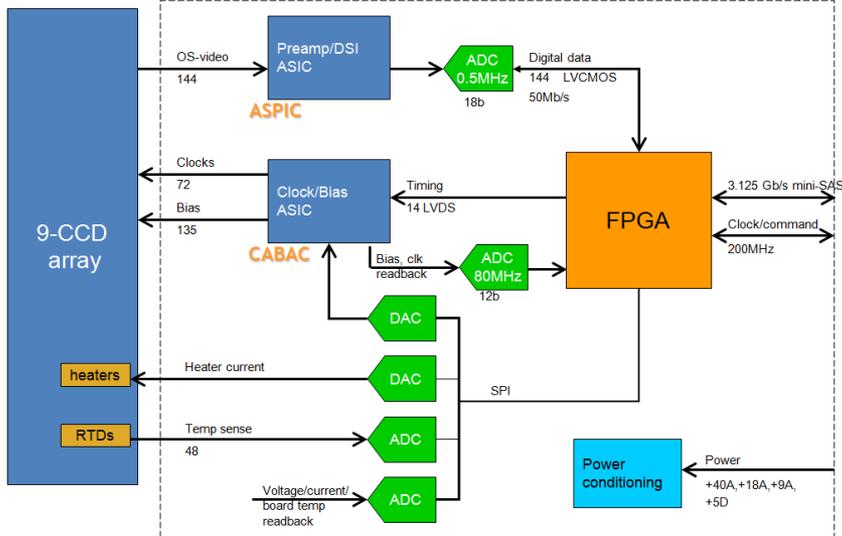
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## Raft tower electronics

### 3X RAFT ELECTRONICS BOARDS (REBs)



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1



## Raft electronics key requirements

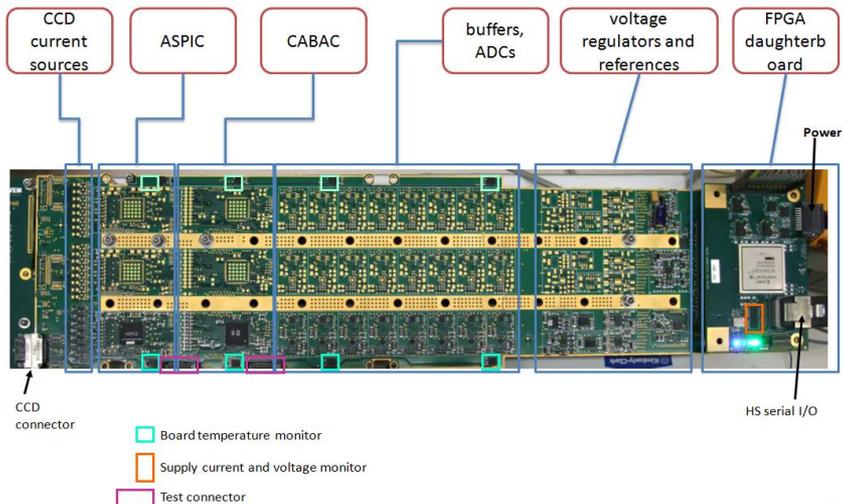
<b>CCD bias</b>	Provide programmable voltages for all CCD biases, except back depletion voltage
<b>CCD clocking</b>	Provide switches and programmable rail voltages/slew rate for all CCD clocks
<b>Sequencer</b>	Timing generator for CCD clocks, CDS switches, ADCs. <b>Independent state machines for each CCD.</b>
<b>Video processing</b>	CDS by dual slope integration for 48 video channels Pixel rate <b>545kpix/s</b> <b>Noise &lt;9e-</b> <b>Crosstalk &lt;0.2%</b> Nonlinearity < 2%, 1 – 90ke- Max signal 175ke-
<b>Data acquisition</b>	<b>18b sampling</b> , 48 channels @545kpix/s Serialize with ECC. No frame buffer on REB 3.125Gbps Cu link to optical TX/RX
<b>Slow controls and monitoring</b>	Configure ASICs Monitor board and CCD temperatures, P/S current and voltage Read serial ID chip CCD protection
<b>Special diagnostic port</b>	Read back CCD bias voltages 80MSa/s ADC to monitor CCD clocks via mux on CABAC
<b>Environmental</b>	Vacuum operation; -40C coldsink.; low outgassing; <b>power ≤ 350mW/chan</b>

# P. O'Connor – LSST integrated readout: implementation



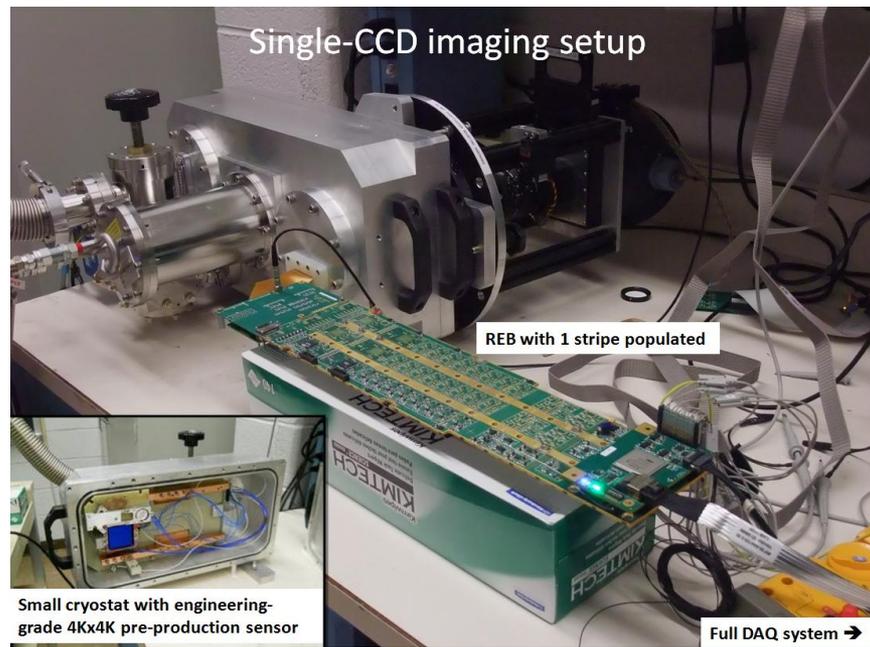
raft electronics board (REB)

STRIPE 1 POPULATED

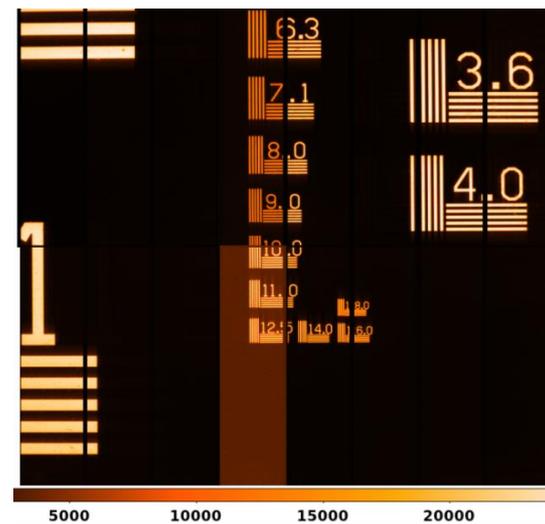
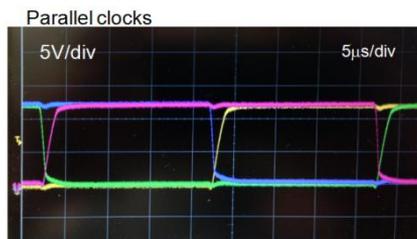
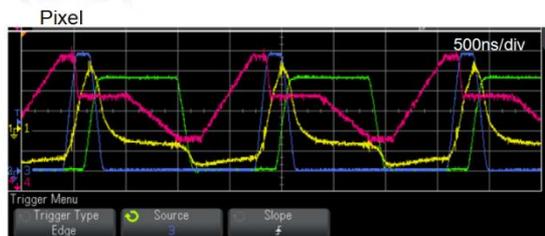


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- Each REB serves 3 CCDs of 16 channels each.
- 12 ASICs for video processing, clock and bias generation
- TV,I monitors
- 18b SAR ADCs (48)
- Virtex5 FPGA
- 3.125Gbps link

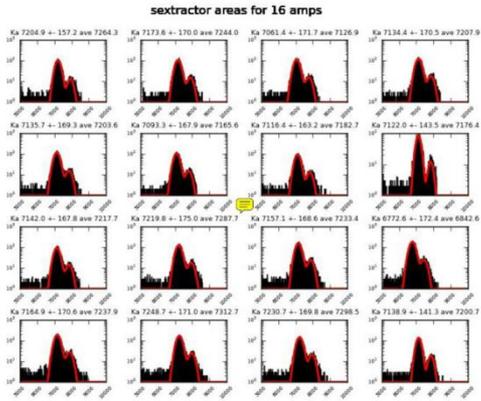




# P. O'Connor – LSST integrated readout: results



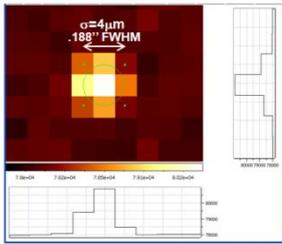
## Spectra with $K\alpha$ , $K\beta$ peaks



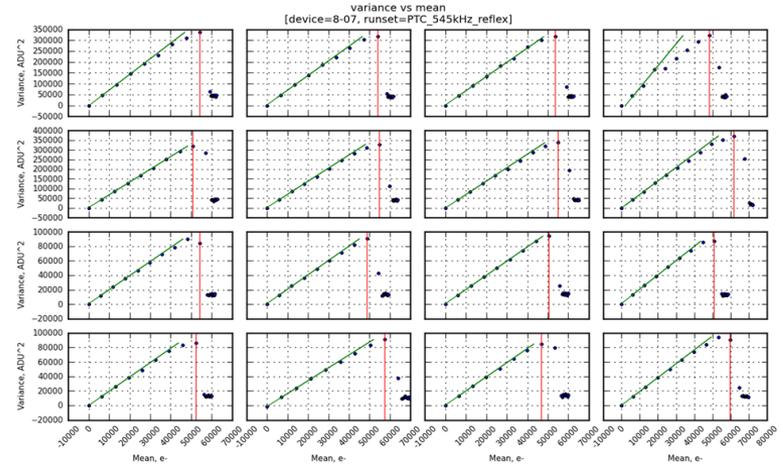
Gain dispersion 1.5%

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## Single cluster (zoom)



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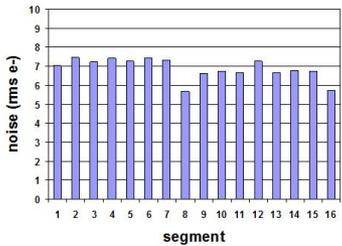
Full well capacity of CCD is ~140ke-; dynamic range of REB1 limited to ~60-80ke- with current gain setup

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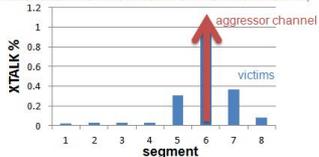
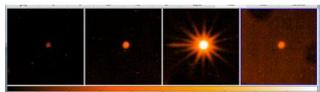


## Noise, crosstalk, nonlinearity

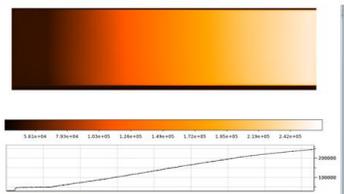
480kpix/s



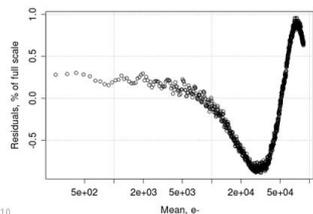
\*REB noise is 1.5-2.2 e-



\*REB xtalk is ≤ 0.04%



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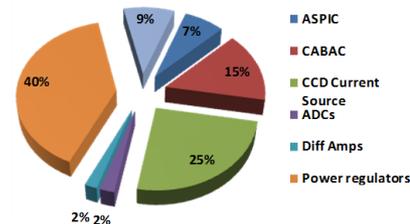


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## Electronics power dissipation

Source	Peak power dissipation, W	
	Per REB	Per channel
CCD current source	4.21	.088
Video ASIC	1.20	.025
Clock/bias ASIC	2.52	.053
ADC differential buffer/driver	0.31	.0065
ADC	0.36	.0075
Power Regulators	6.63	.138
Control FPGA	1.50	.031
<b>TOTAL Electronics Power</b>	<b>16.73</b>	<b>0.349</b>



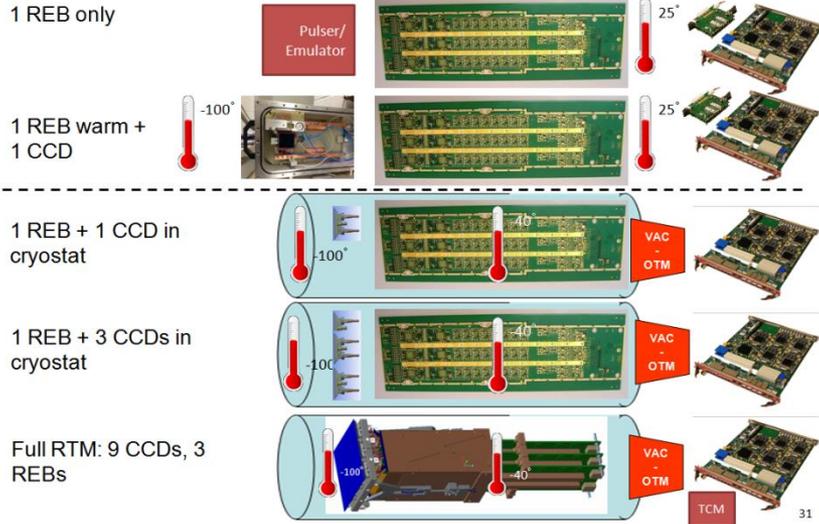
Measured (on single-stripe REB)	
Expose	6.98W
Readout	8.96W

Ave(LSST cadence) ~ 7W  
30% power common  
≈.35W/chan for fully-populated REB ✓

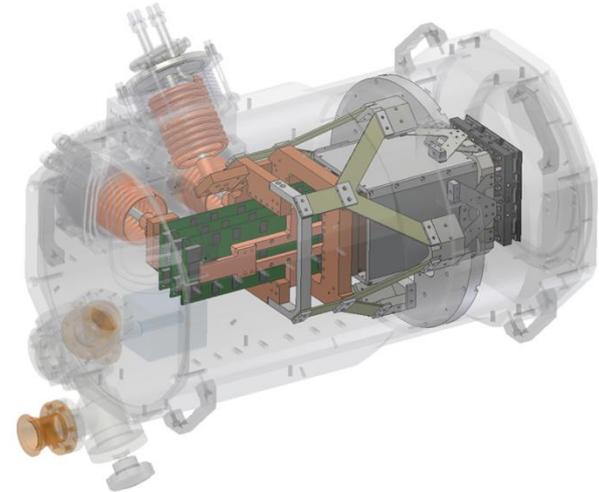


# P. O'Connor – LSST integrated readout: plans

## LSST Next steps



## LSST mechanics and thermal



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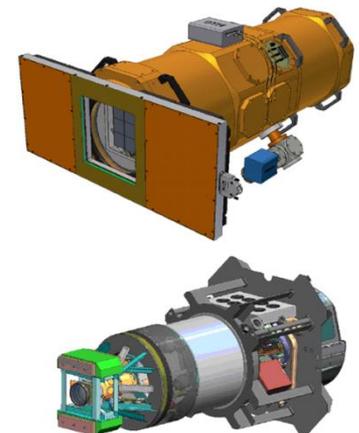
J. Haupt 34



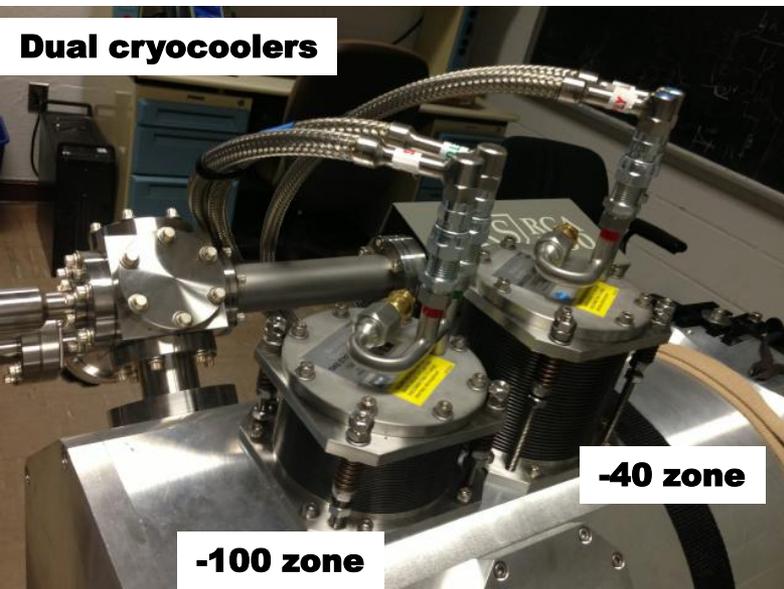
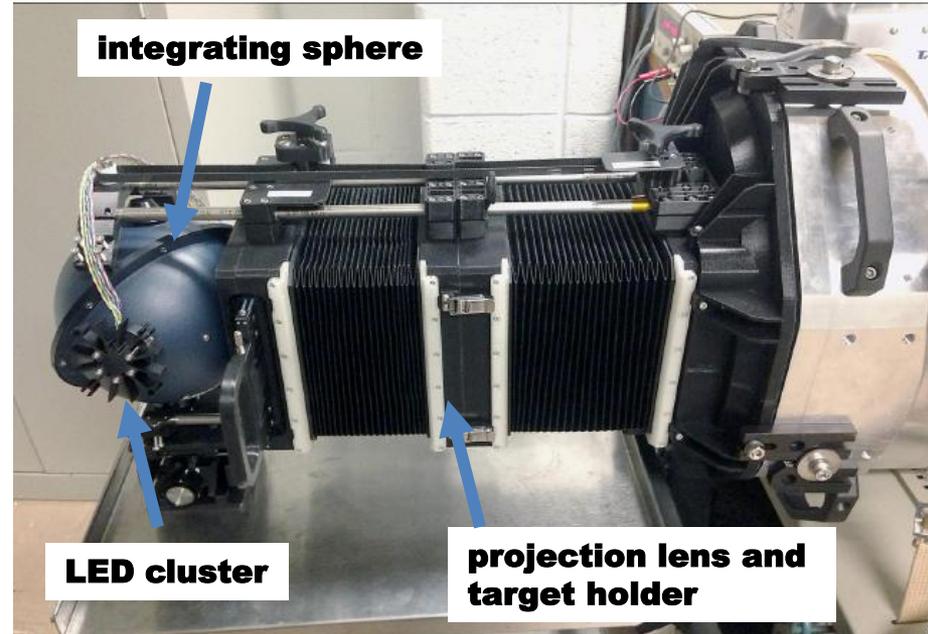
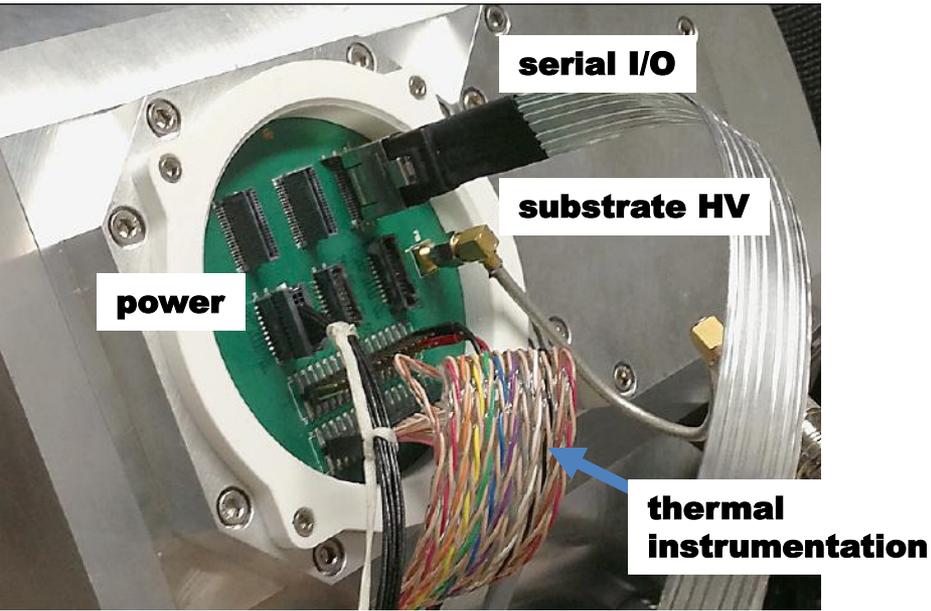
vacuum enclosure under test

## LSST proposed LSST commissioning camera (ComCam)

- Raft test cryostat with 9 engineering-grade CCDs, full electronics and DAQ, LN2 cooling, shutter, corrector + filters
- Installed on camera hexapod/rotator at LSST 3-mirror focus prior to full Camera readiness
- 30 arcmin field on-axis
- Early commissioning studies

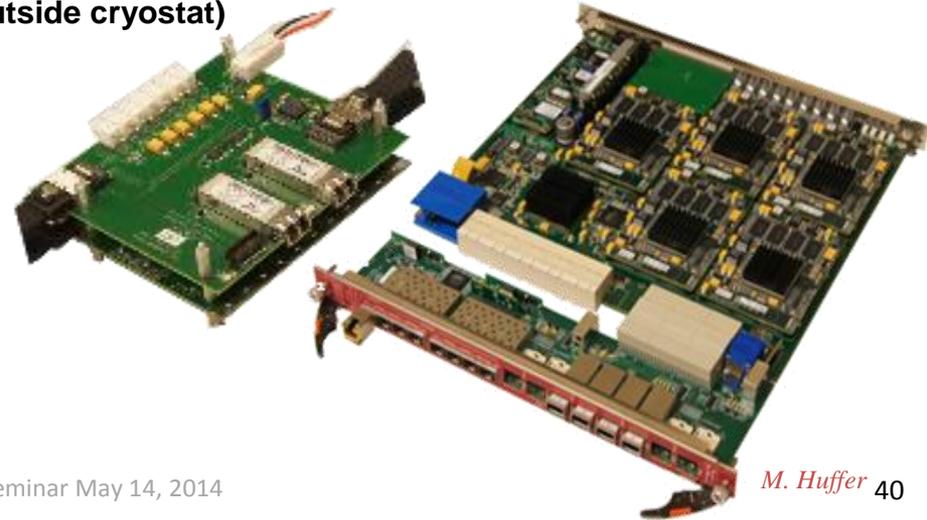


# 3 Camera details - external



Optical transition module (outside cryostat)

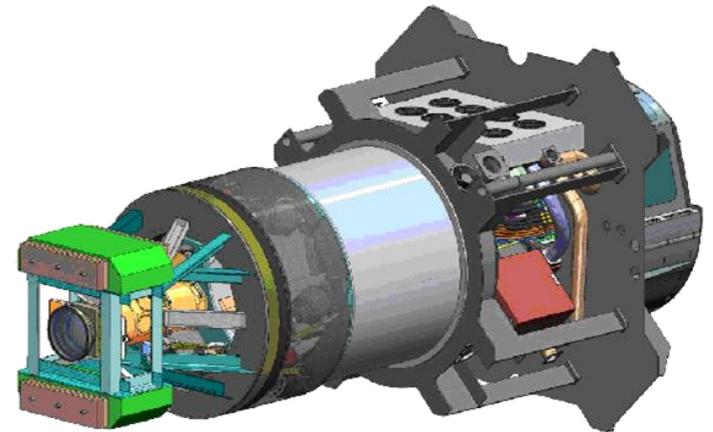
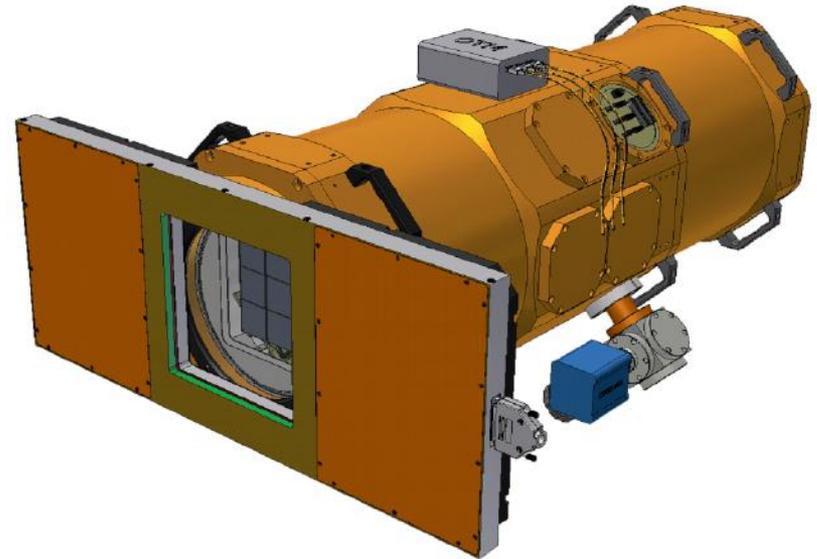
ATCA-based DAQ server





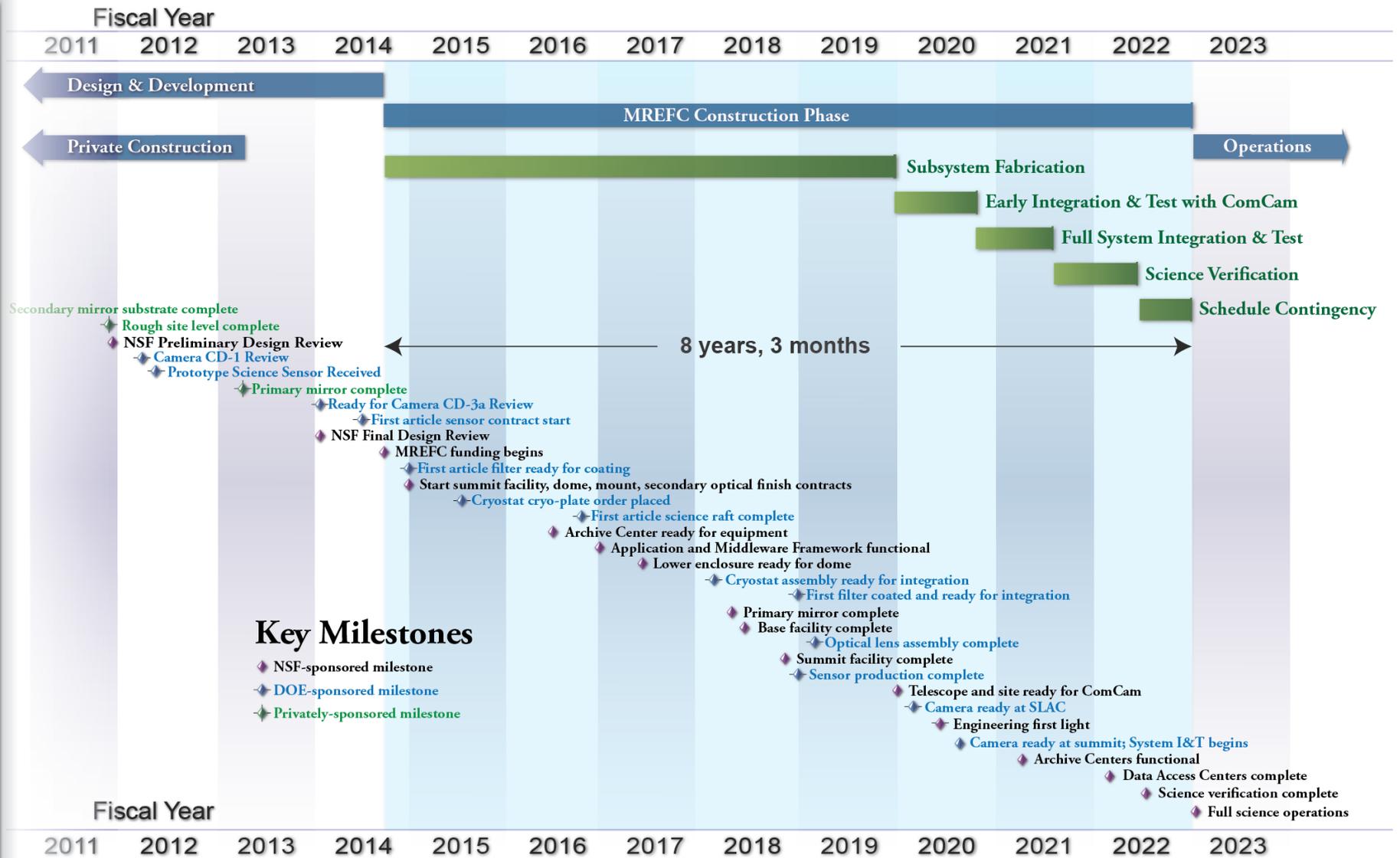
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- 30 arcmin field on-axis
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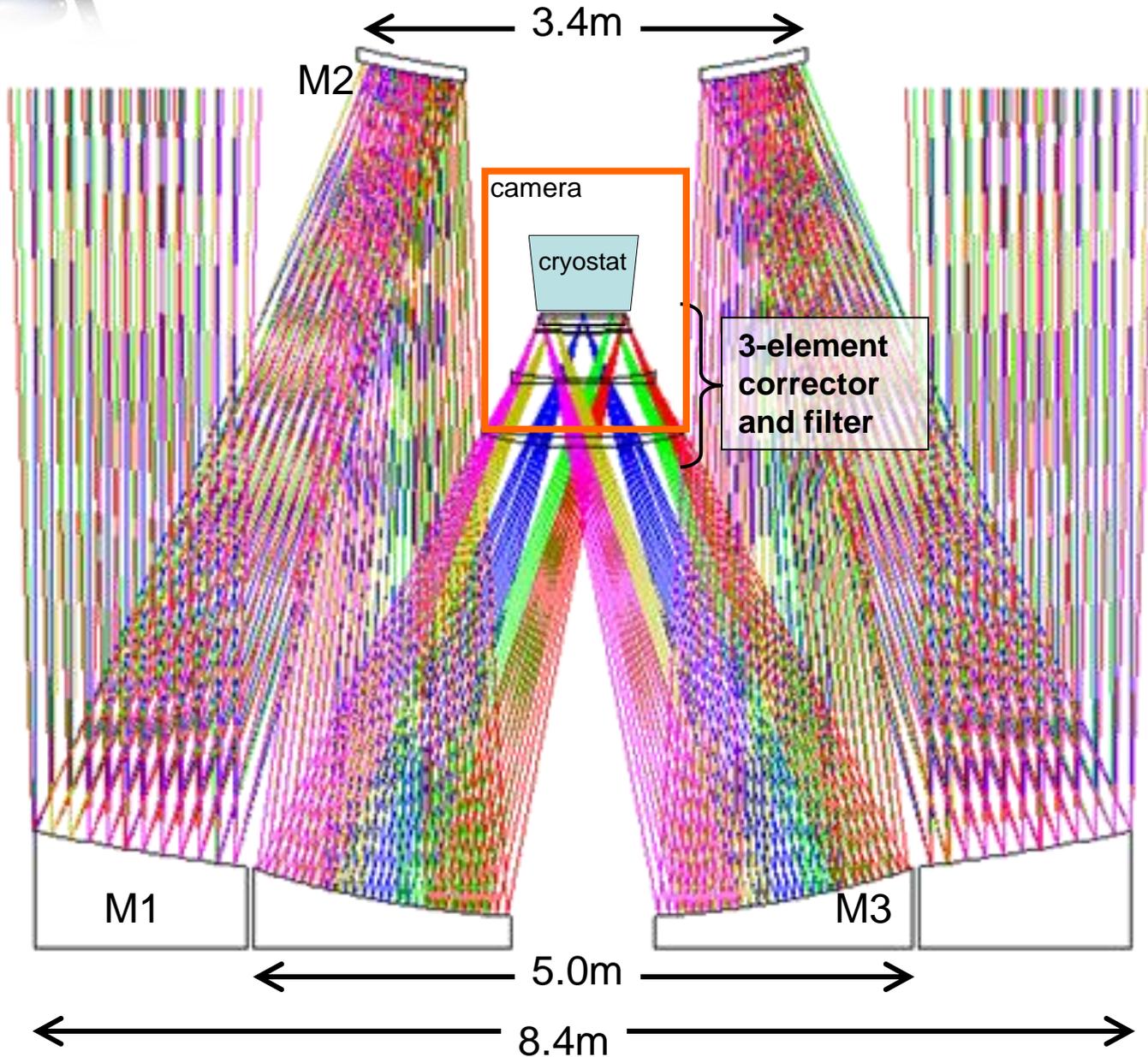
# Integrated Project Schedule



Sept 2013



# Optical configuration





Major actions and approvals at the 436th meeting of the Board included the following (not in priority order):

1. The Board authorized the NSF Deputy Director, at her discretion, to make an award for the construction of the Large Synoptic Survey Telescope (LSST).